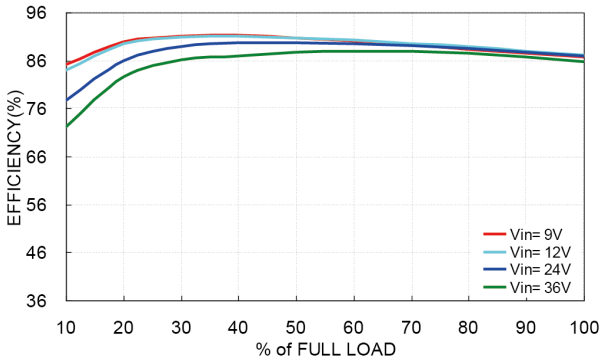
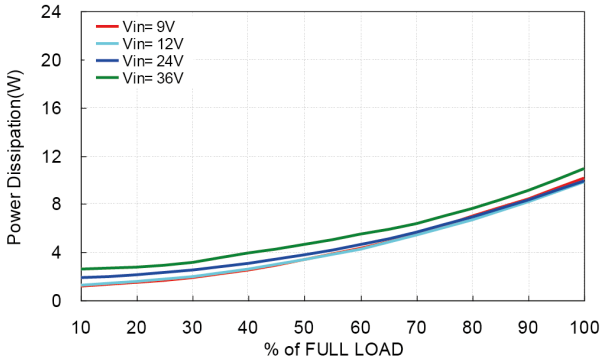
Characteristic Curves

On demand model with 24 Vin and 3.3 Vout
On demand model with 24 Vin and 3.3 Vout for chassis mount
On demand model with 24 Vin and 3.3 Vout for chassis mount and with input filter

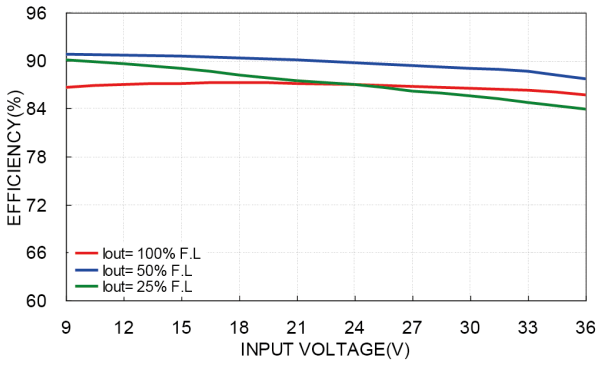
Efficiency versus Output Load



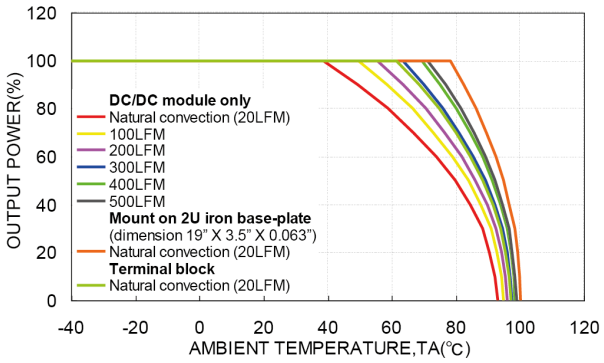
Power Dissipation versus Output Load



Efficiency versus Input Voltage

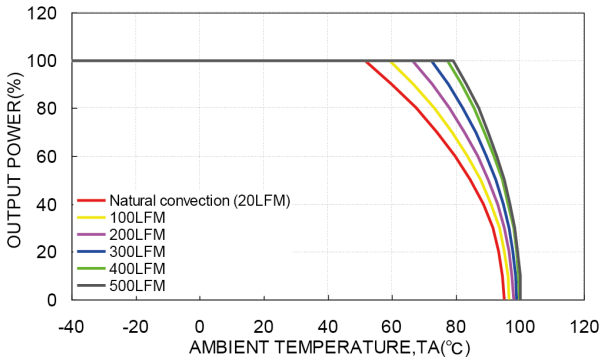


Derating Output Load versus Ambient Temperature



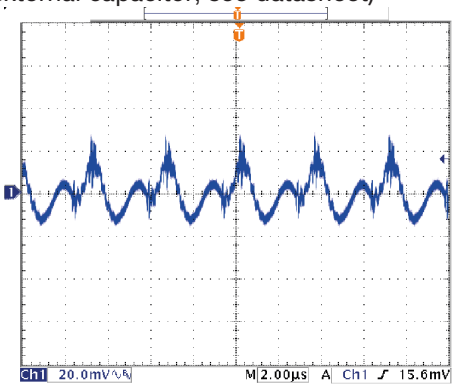
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

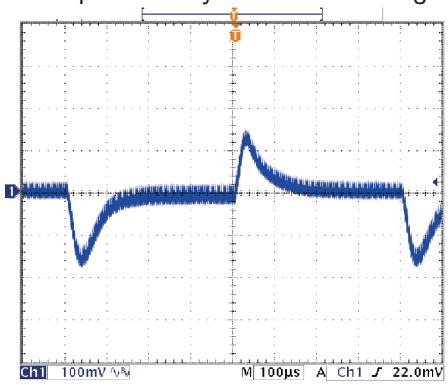


On demand model with 24 Vin and 3.3 Vout
On demand model with 24 Vin and 3.3 Vout for chassis mount
On demand model with 24 Vin and 3.3 Vout for chassis mount and with input filter

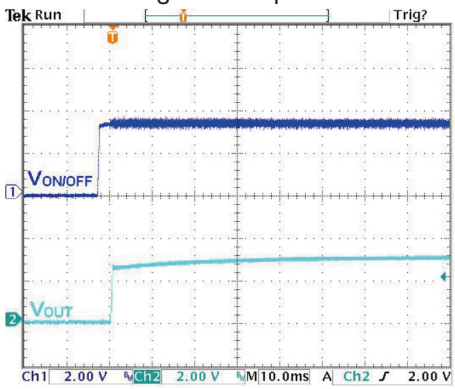
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



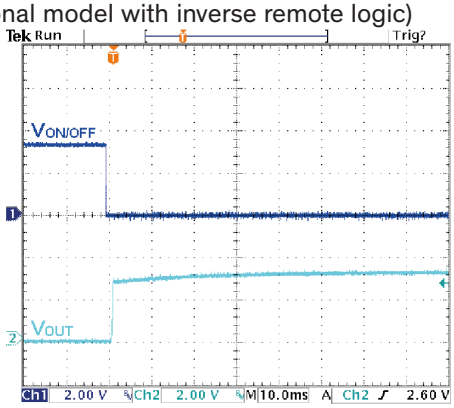
Transient Response to Dynamic Load Change (25%)



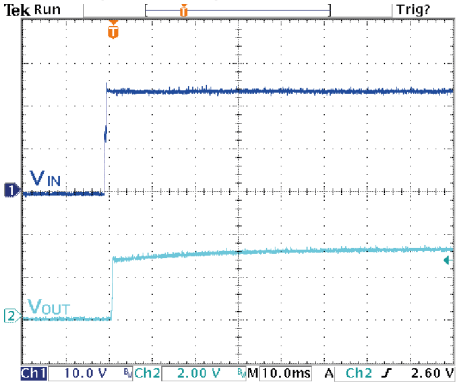
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

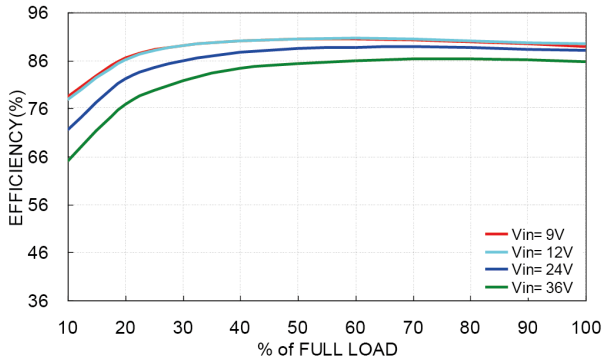


Typical Start-Up and Output Rise Characteristic

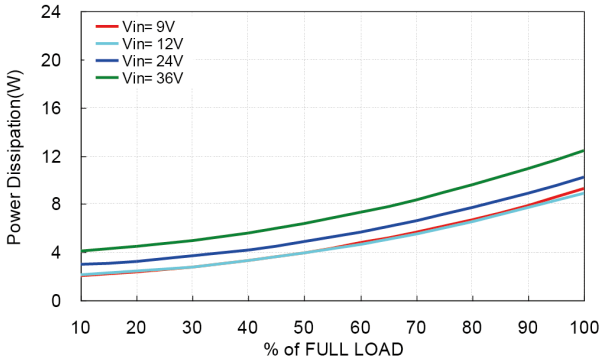


TEP 75-2411WI
TEP 75-2411WI-CM
TEP 75-2411WI-CMF

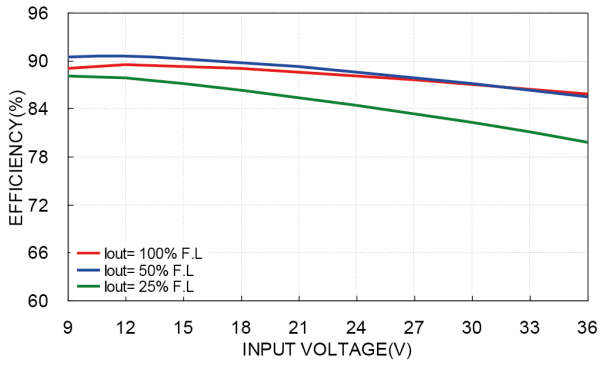
Efficiency versus Output Load



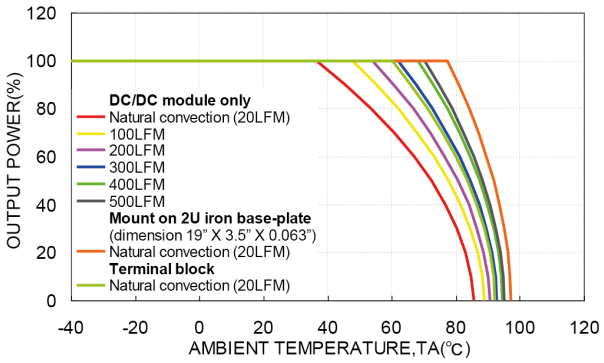
Power Dissipation versus Output Load



Efficiency versus Input Voltage

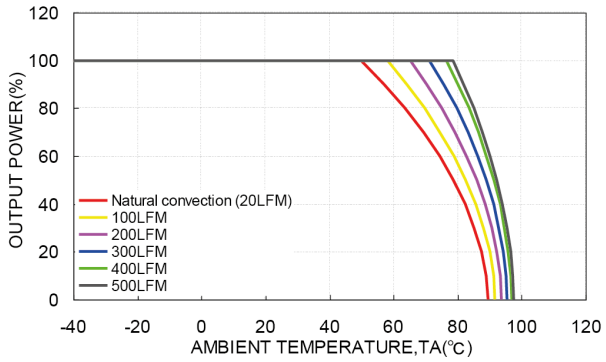


Derating Output Load versus Ambient Temperature



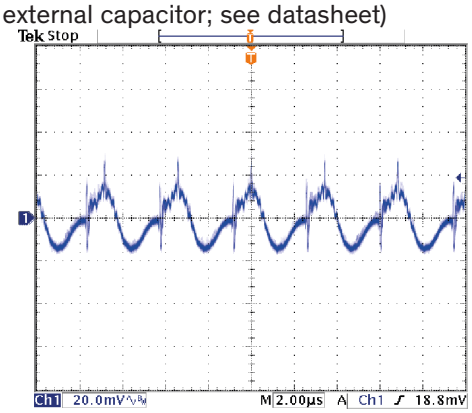
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

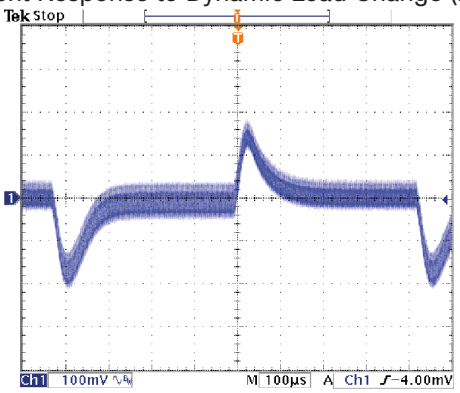


TEP 75-2411WI
TEP 75-2411WI-CM
TEP 75-2411WI-CMF

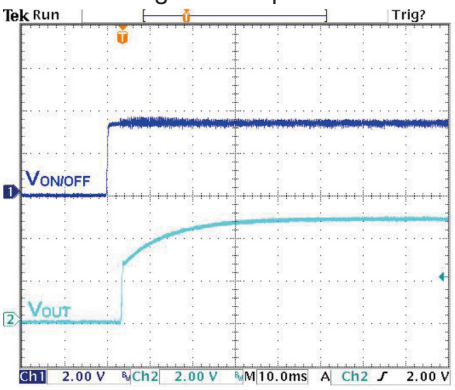
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



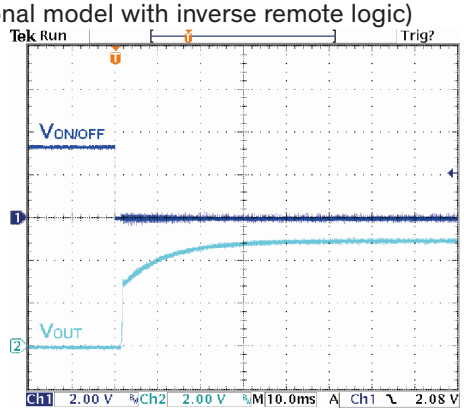
Transient Response to Dynamic Load Change (25%)



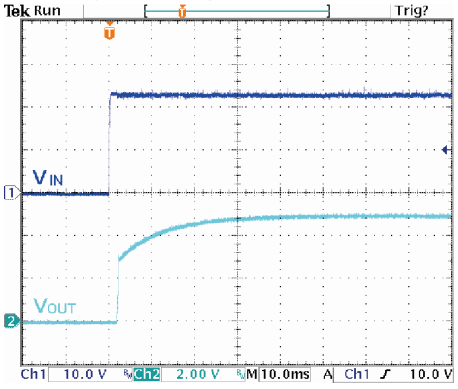
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

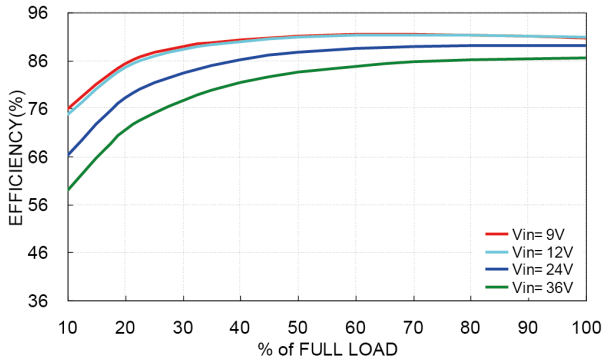


Typical Start-Up and Output Rise Characteristic

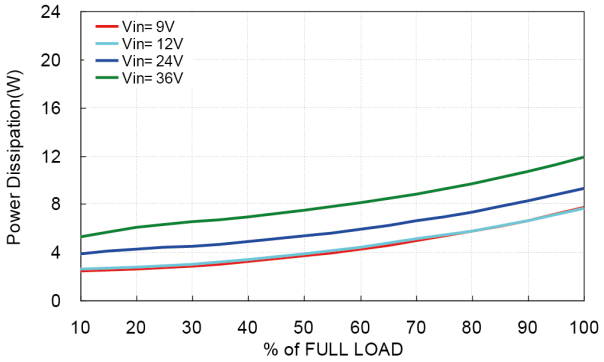


TEP 75-2412WI
TEP 75-2412WI-CM
TEP 75-2412WI-CMF

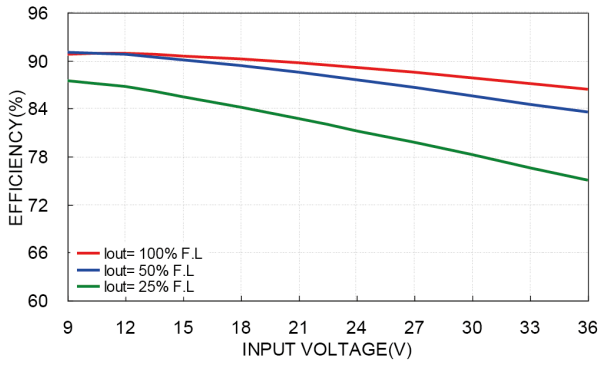
Efficiency versus Output Load



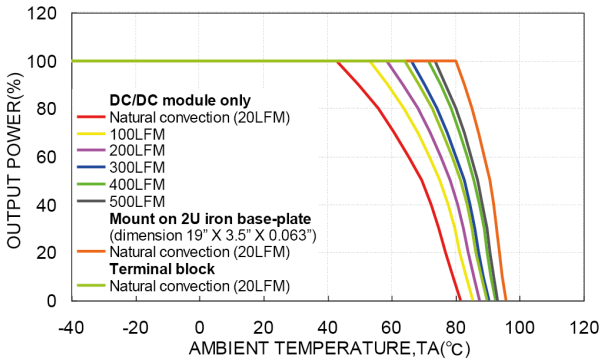
Power Dissipation versus Output Load



Efficiency versus Input Voltage

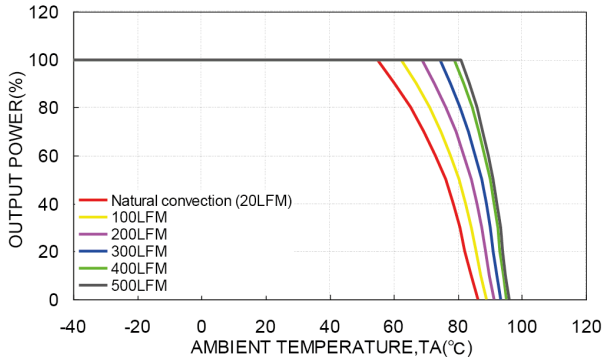


Derating Output Load versus Ambient Temperature



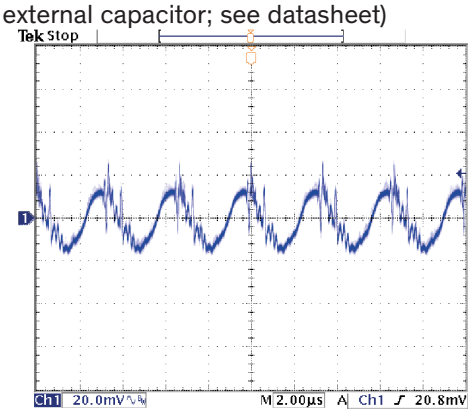
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

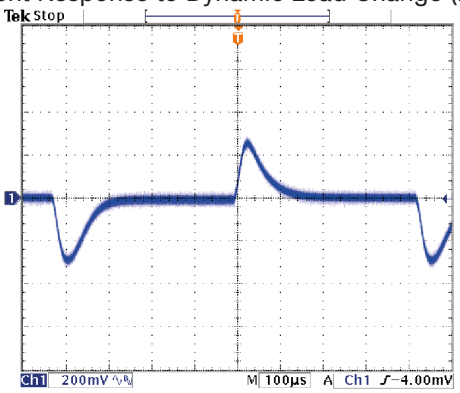


TEP 75-2412WI
TEP 75-2412WI-CM
TEP 75-2412WI-CMF

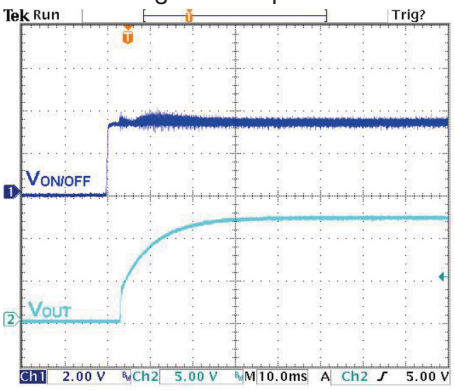
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



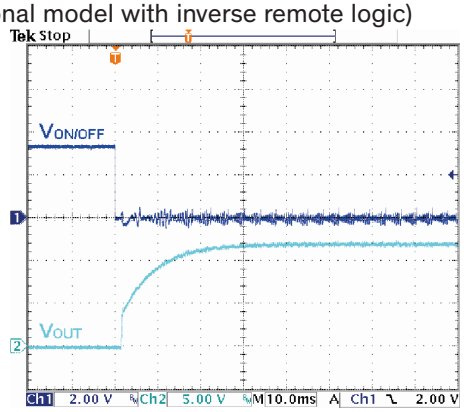
Transient Response to Dynamic Load Change (25%)



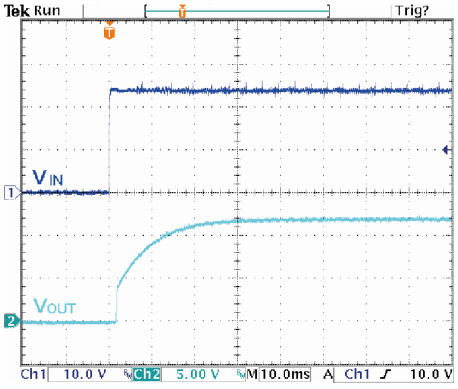
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

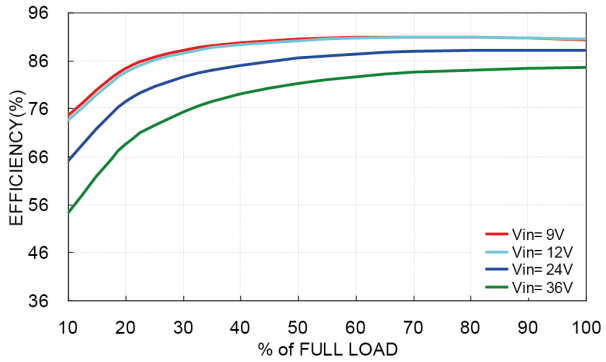


Typical Start-Up and Output Rise Characteristic

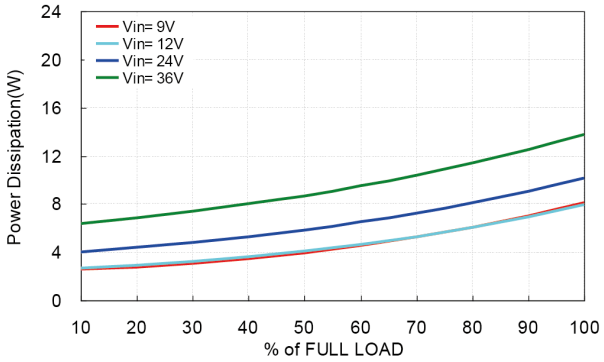


TEP 75-2413WI
TEP 75-2413WI-CM
TEP 75-2413WI-CMF

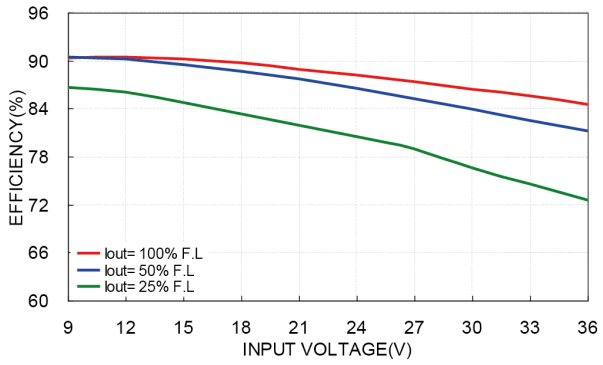
Efficiency versus Output Load



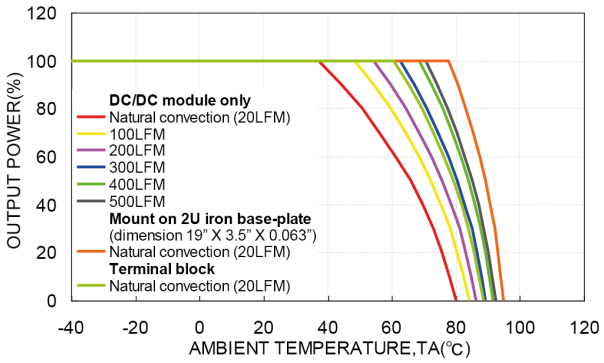
Power Dissipation versus Output Load



Efficiency versus Input Voltage

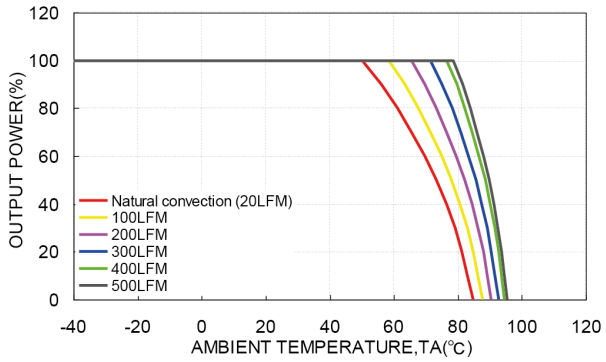


Derating Output Load versus Ambient Temperature



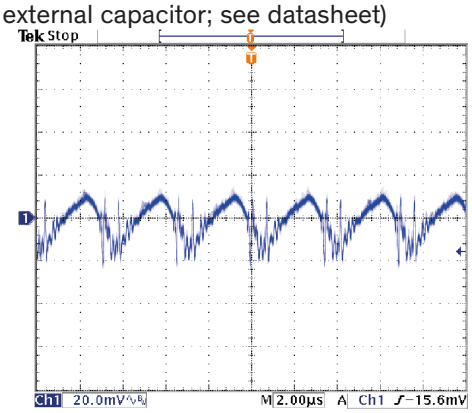
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

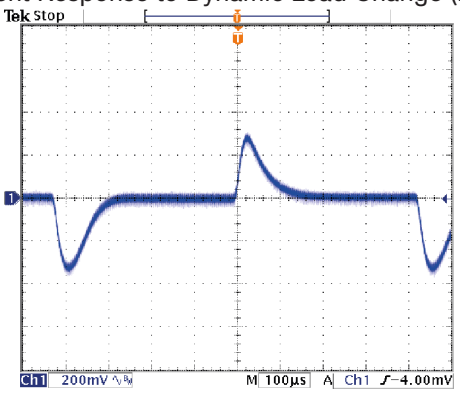


TEP 75-2413WI
TEP 75-2413WI-CM
TEP 75-2413WI-CMF

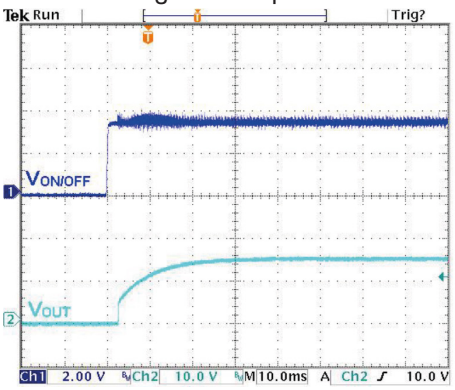
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



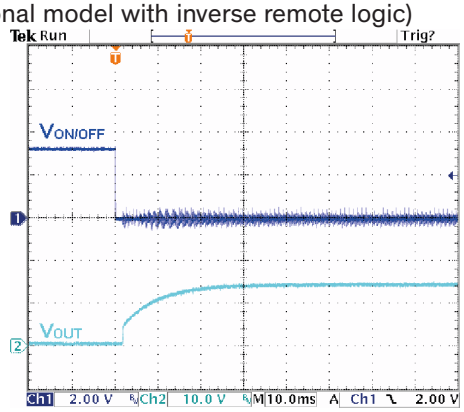
Transient Response to Dynamic Load Change (25%)



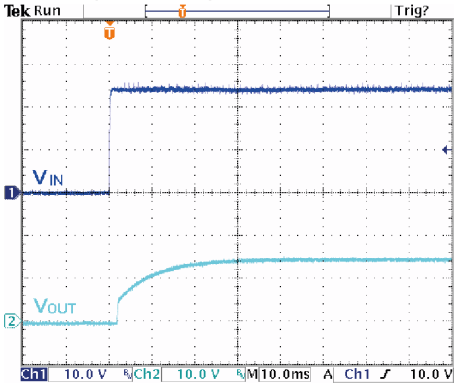
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

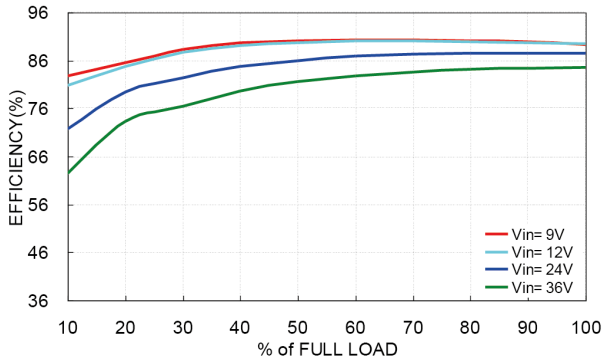


Typical Start-Up and Output Rise Characteristic

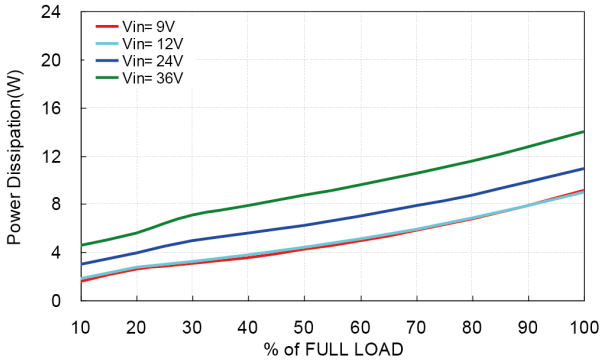


TEP 75-2415WI
TEP 75-2415WI-CM
TEP 75-2415WI-CMF

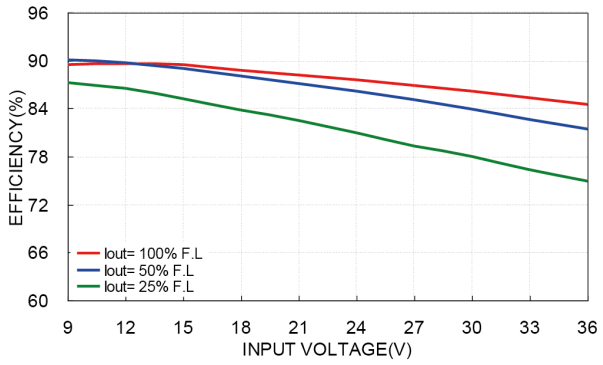
Efficiency versus Output Load



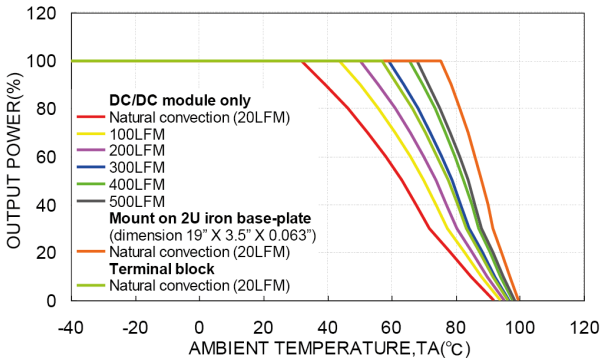
Power Dissipation versus Output Load



Efficiency versus Input Voltage

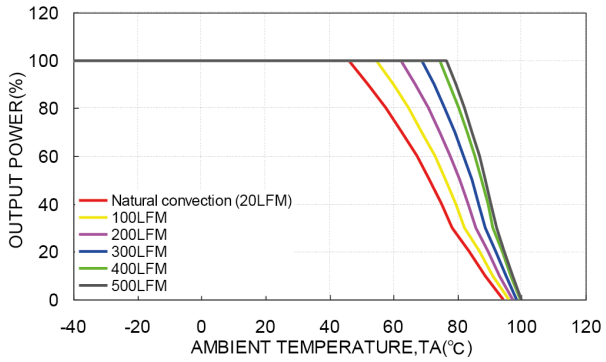


Derating Output Load versus Ambient Temperature



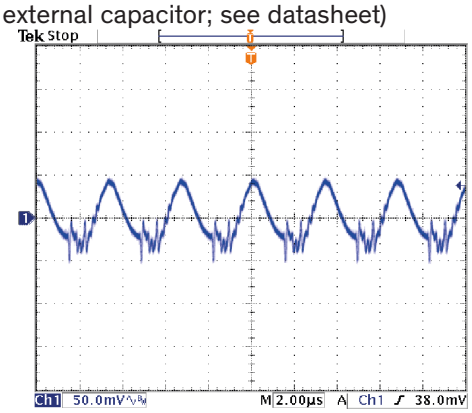
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

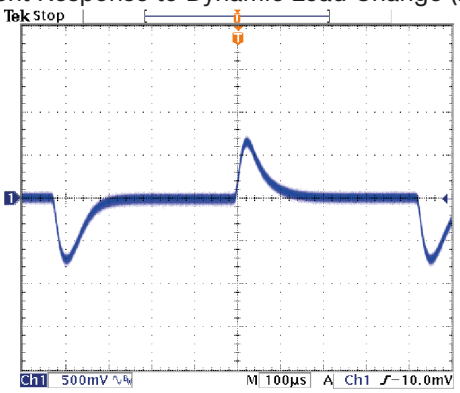


TEP 75-2415WI
TEP 75-2415WI-CM
TEP 75-2415WI-CMF

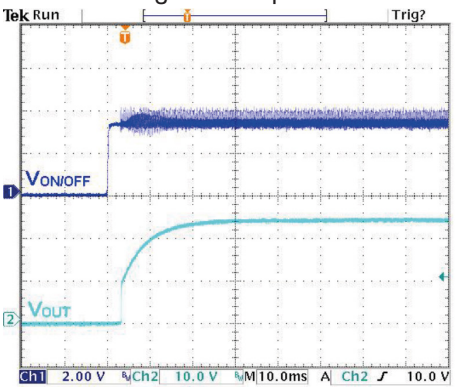
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



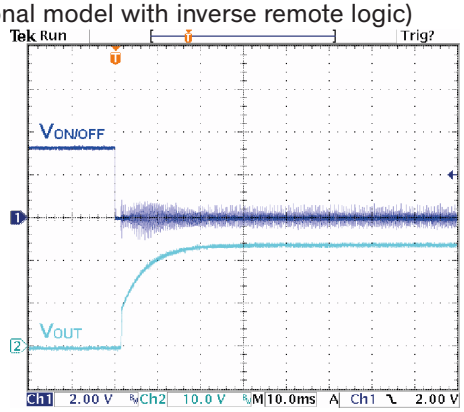
Transient Response to Dynamic Load Change (25%)



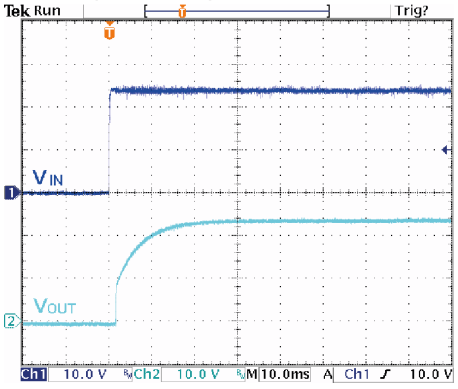
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

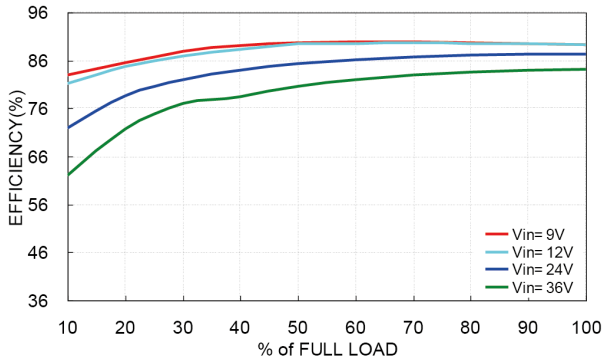


Typical Start-Up and Output Rise Characteristic

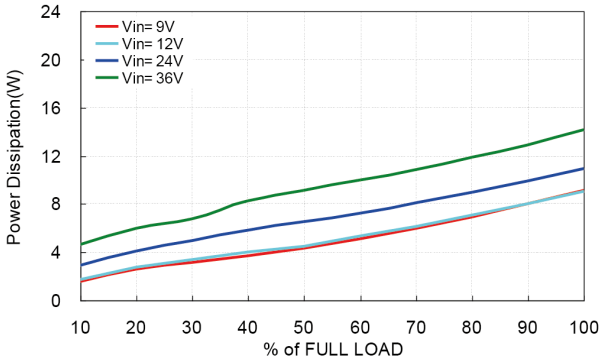


TEP 75-2416WI
TEP 75-2416WI-CM
TEP 75-2416WI-CMF

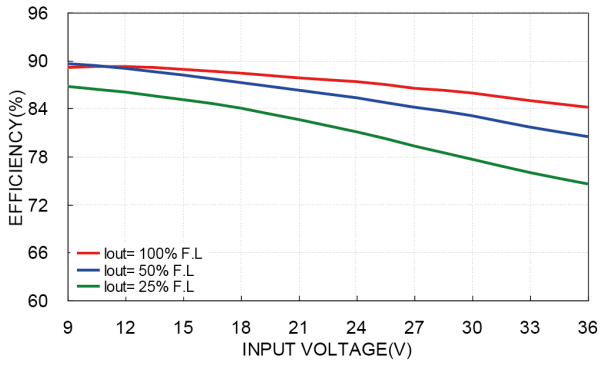
Efficiency versus Output Load



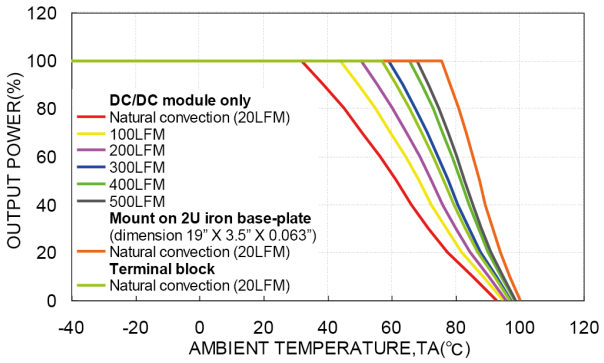
Power Dissipation versus Output Load



Efficiency versus Input Voltage

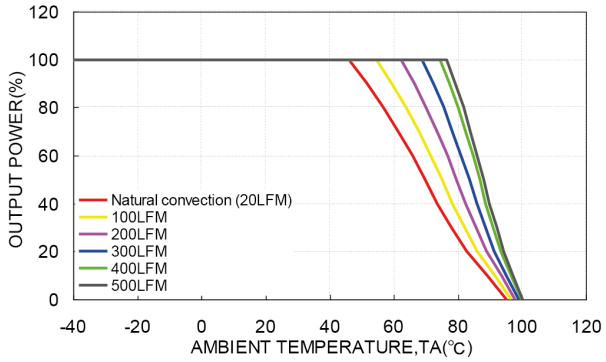


Derating Output Load versus Ambient Temperature



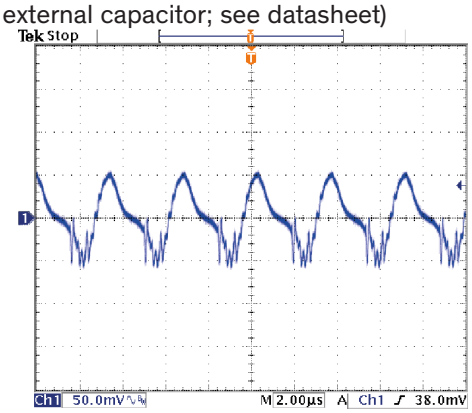
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

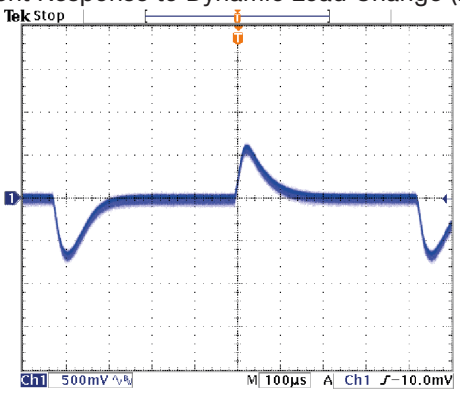


TEP 75-2416WI
TEP 75-2416WI-CM
TEP 75-2416WI-CMF

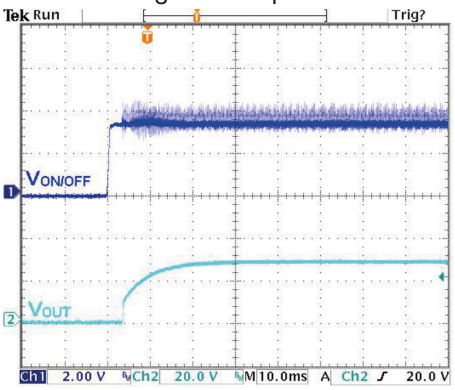
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



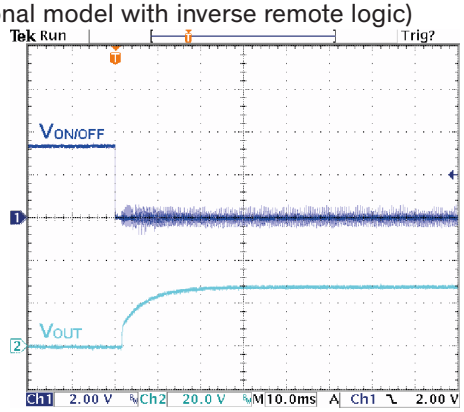
Transient Response to Dynamic Load Change (25%)



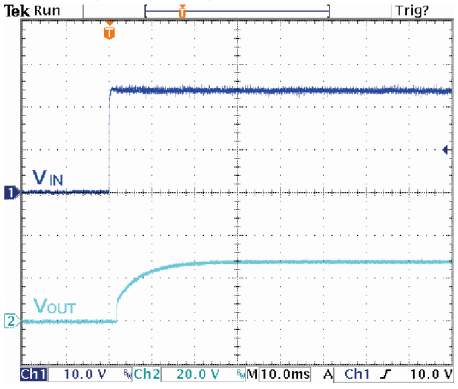
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

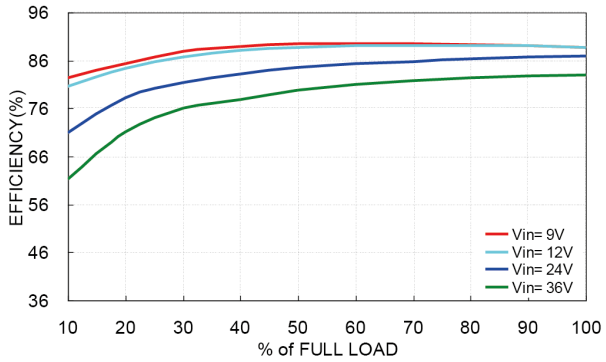


Typical Start-Up and Output Rise Characteristic

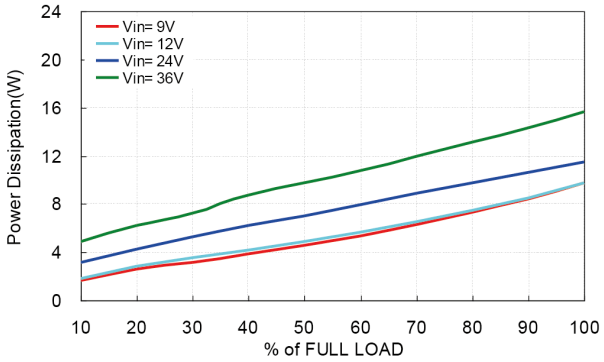


TEP 75-2418WI
TEP 75-2418WI-CM
TEP 75-2418WI-CMF

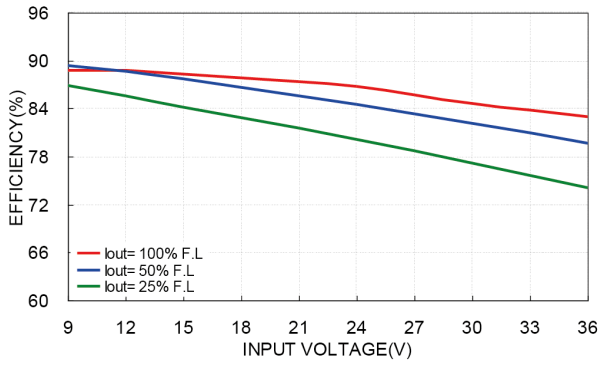
Efficiency versus Output Load



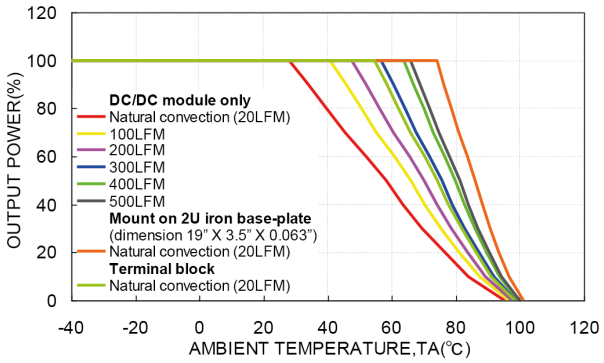
Power Dissipation versus Output Load



Efficiency versus Input Voltage

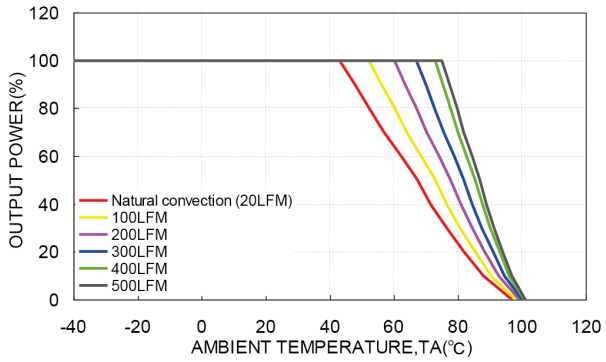


Derating Output Load versus Ambient Temperature



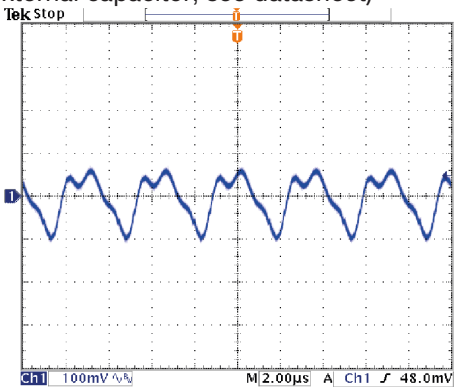
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

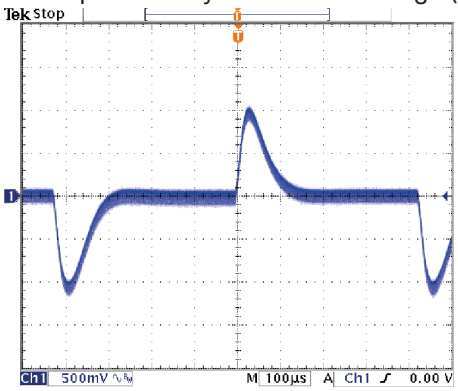


TEP 75-2418WI
TEP 75-2418WI-CM
TEP 75-2418WI-CMF

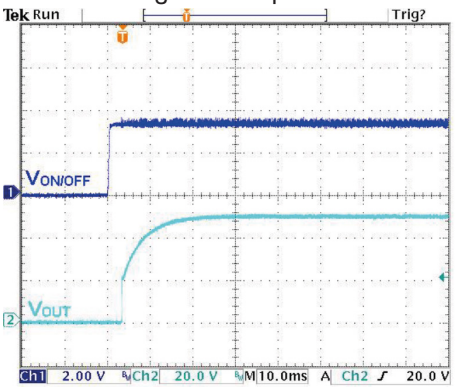
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



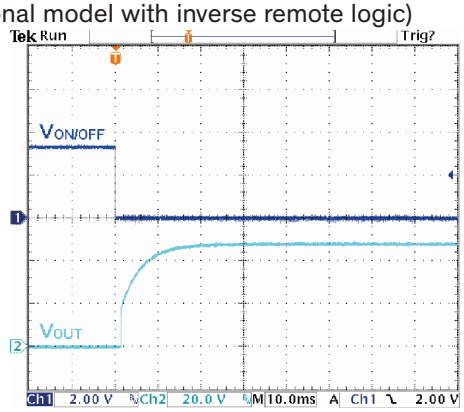
Transient Response to Dynamic Load Change (25%)



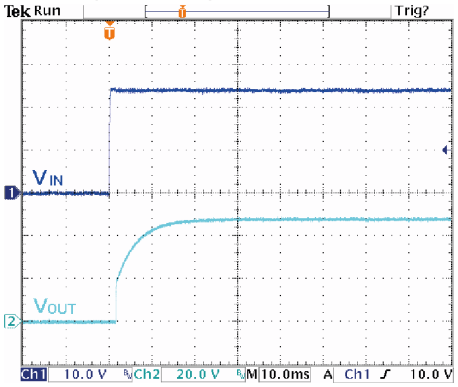
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

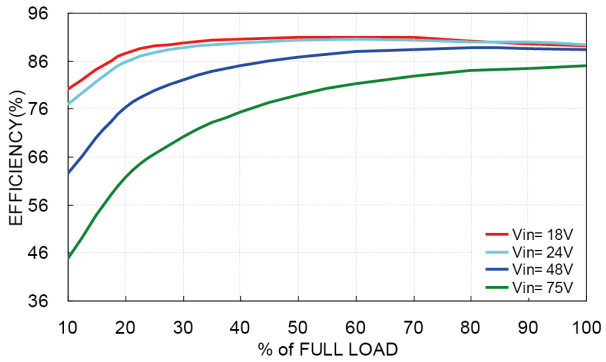


Typical Start-Up and Output Rise Characteristic

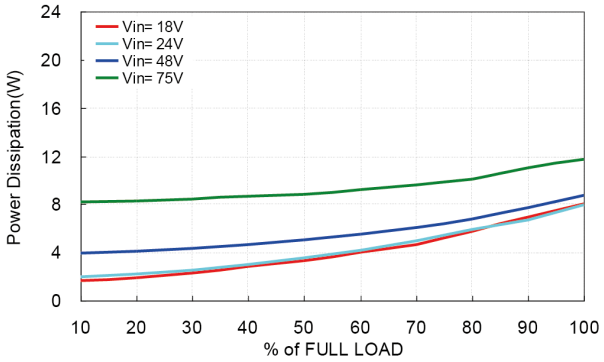


On demand model with 48 Vin and 3.3 Vout
On demand model with 48 Vin and 3.3 Vout for chassis mount
On demand model with 48 Vin and 3.3 Vout for chassis mount and with input filter

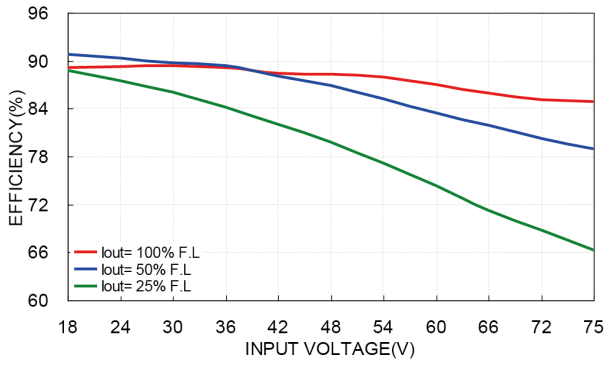
Efficiency versus Output Load



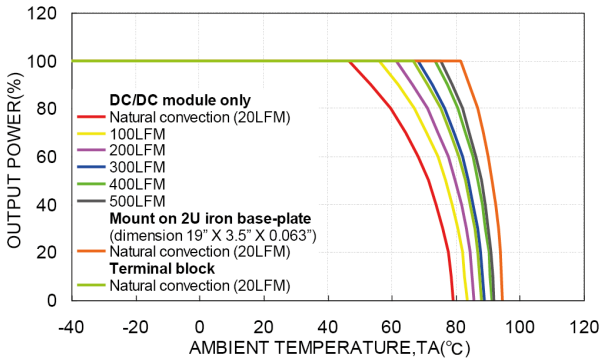
Power Dissipation versus Output Load



Efficiency versus Input Voltage

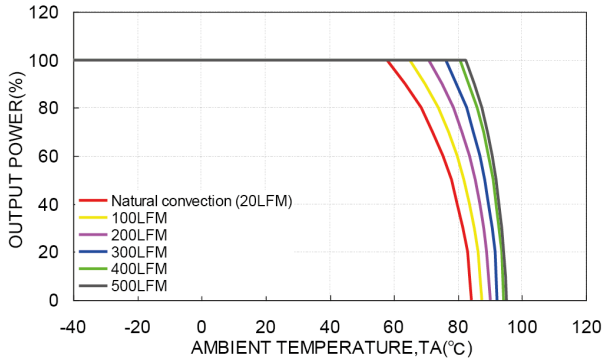


Derating Output Load versus Ambient Temperature



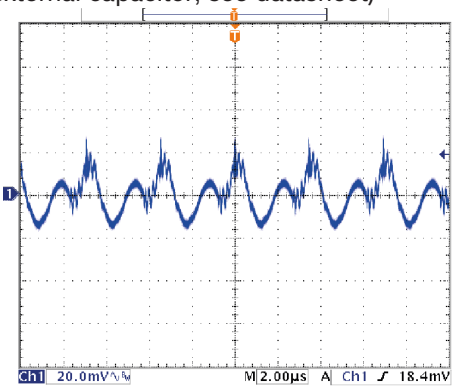
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

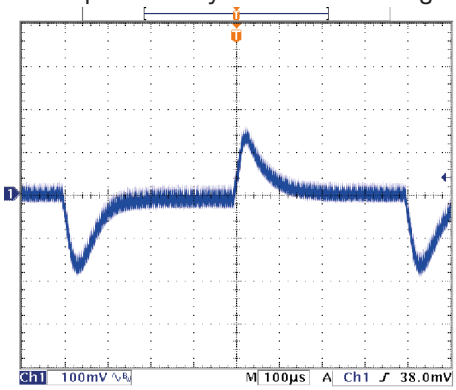


On demand model with 48 Vin and 3.3 Vout
On demand model with 48 Vin and 3.3 Vout for chassis mount
On demand model with 48 Vin and 3.3 Vout for chassis mount and with input filter

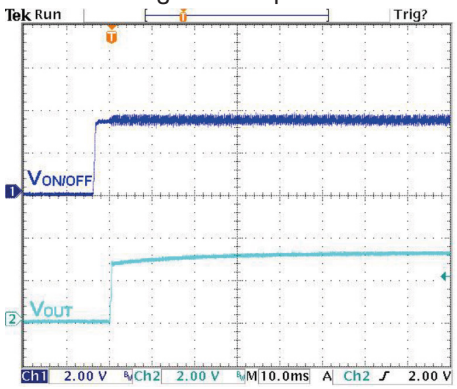
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



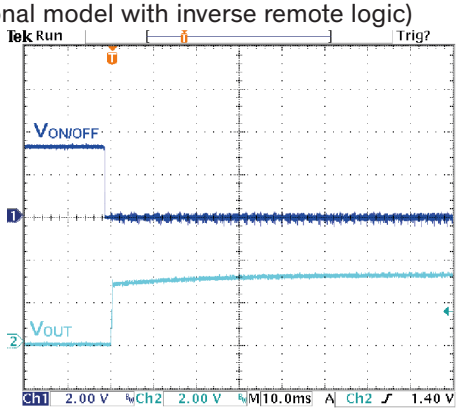
Transient Response to Dynamic Load Change (25%)



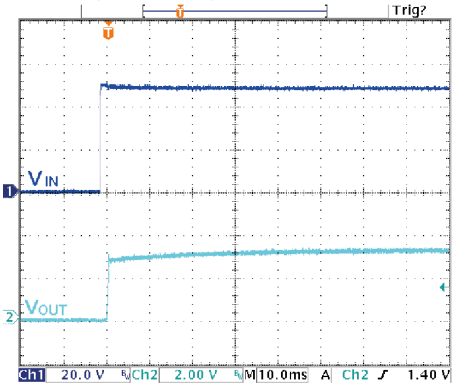
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

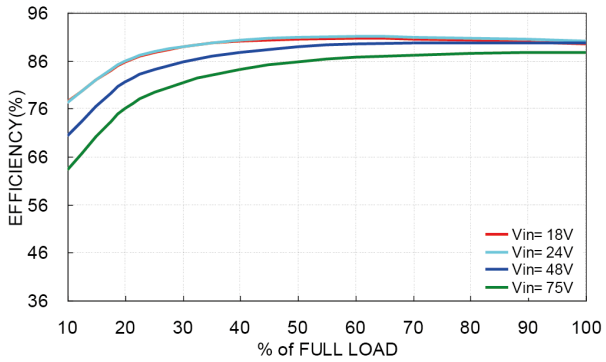


Typical Start-Up and Output Rise Characteristic

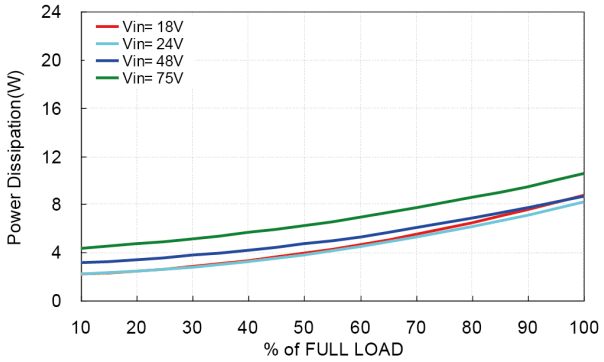


TEP 75-4811WI
TEP 75-4811WI-CM
TEP 75-4811WI-CMF

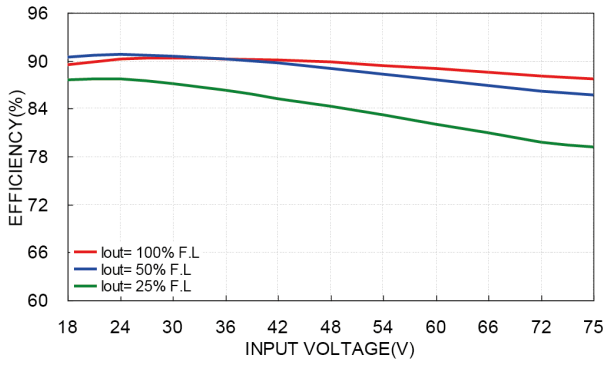
Efficiency versus Output Load



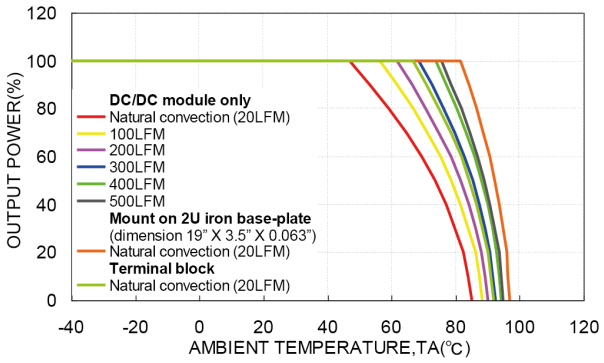
Power Dissipation versus Output Load



Efficiency versus Input Voltage

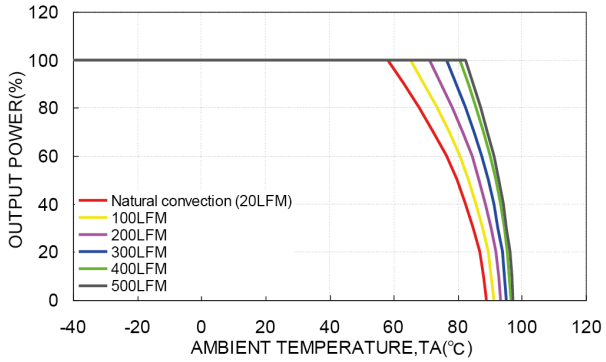


Derating Output Load versus Ambient Temperature



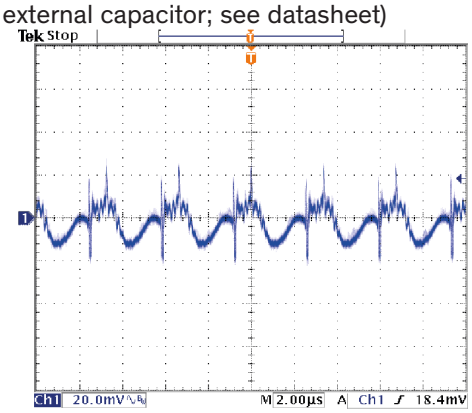
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

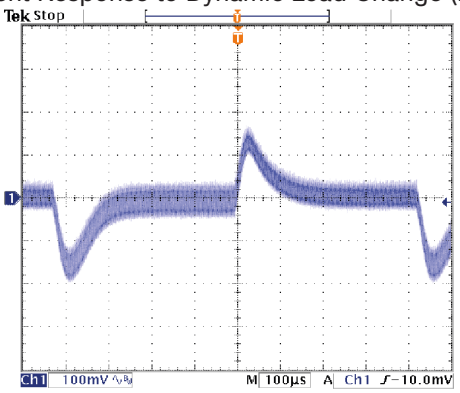


TEP 75-4811WI
TEP 75-4811WI-CM
TEP 75-4811WI-CMF

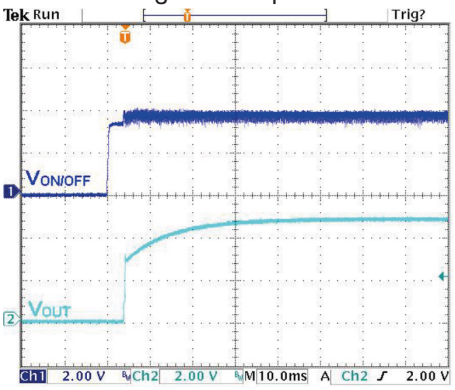
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



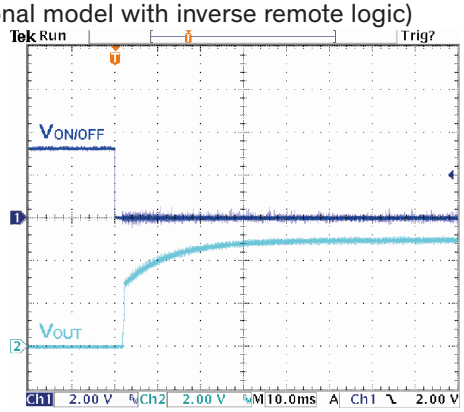
Transient Response to Dynamic Load Change (25%)



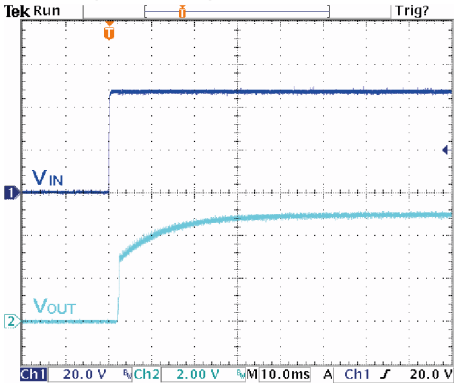
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

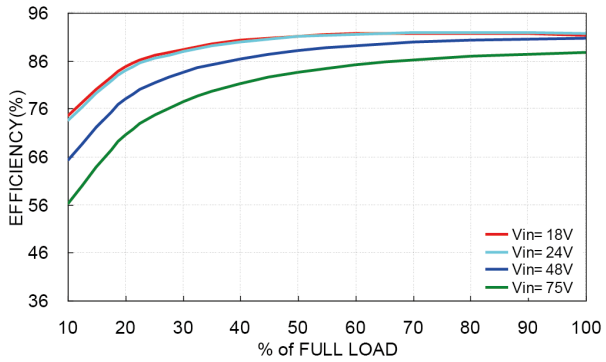


Typical Start-Up and Output Rise Characteristic

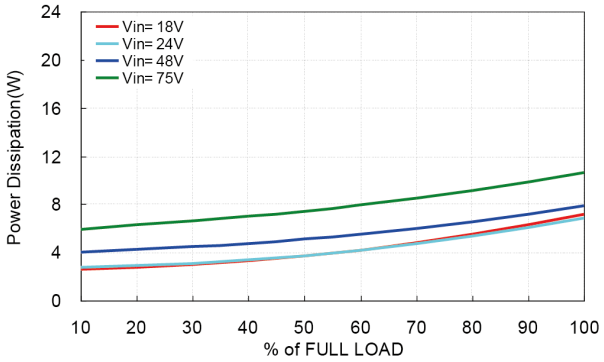


TEP 75-4812WI
TEP 75-4812WI-CM
TEP 75-4812WI-CMF

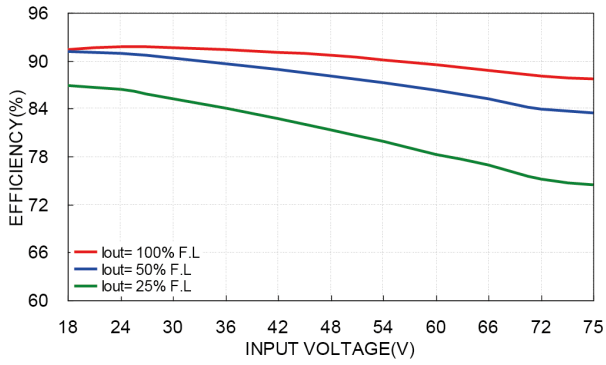
Efficiency versus Output Load



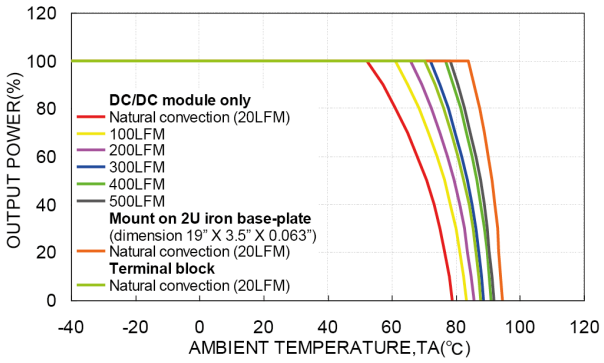
Power Dissipation versus Output Load



Efficiency versus Input Voltage

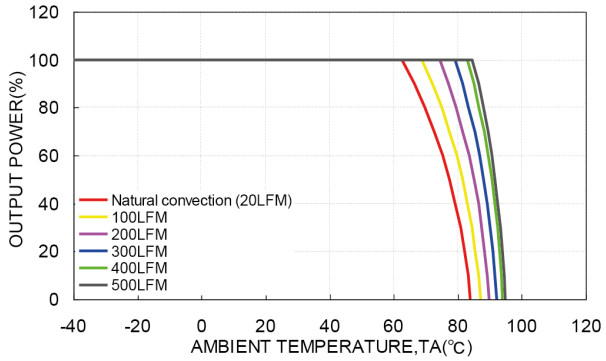


Derating Output Load versus Ambient Temperature



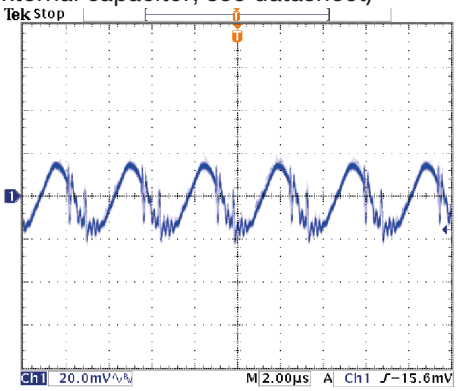
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

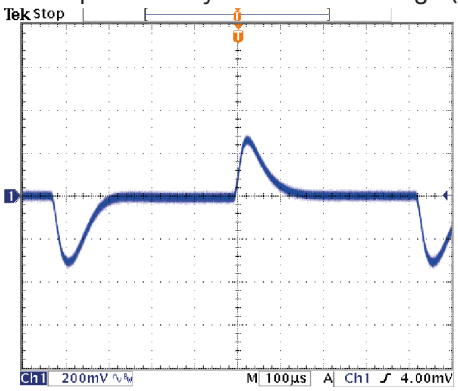


TEP 75-4812WI
TEP 75-4812WI-CM
TEP 75-4812WI-CMF

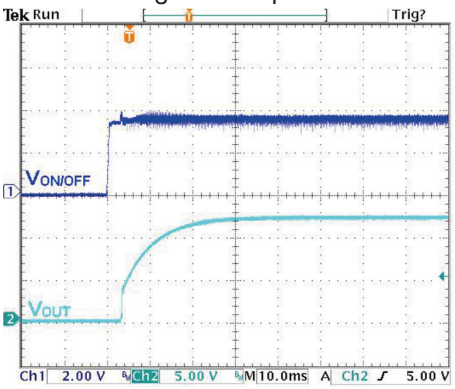
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



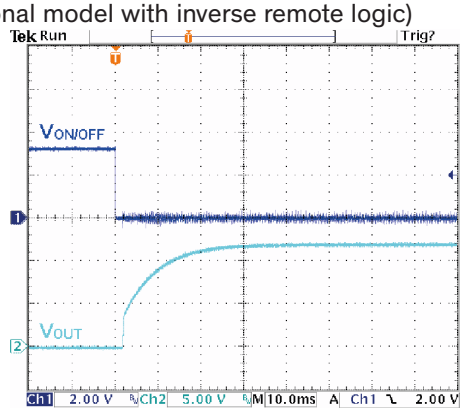
Transient Response to Dynamic Load Change (25%)



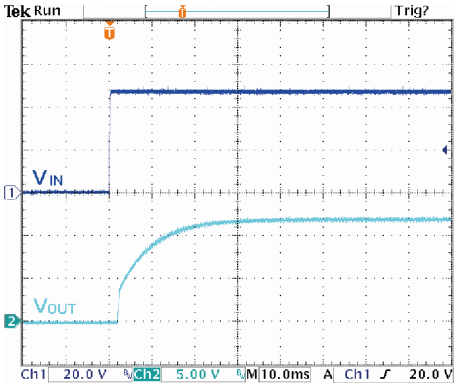
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

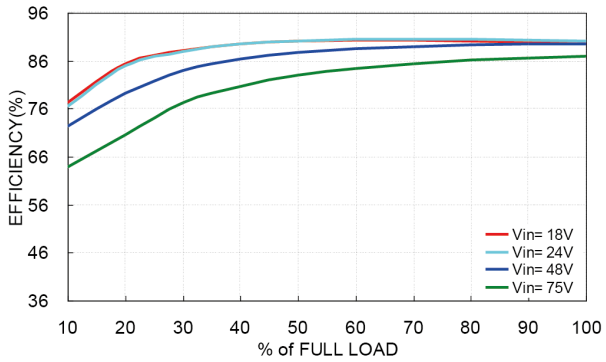


Typical Start-Up and Output Rise Characteristic

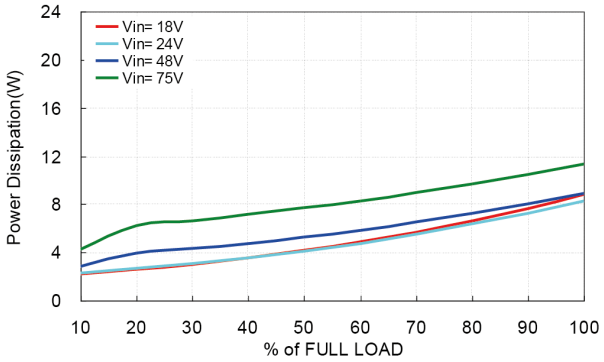


TEP 75-4813WI
TEP 75-4813WI-CM
TEP 75-4813WI-CMF

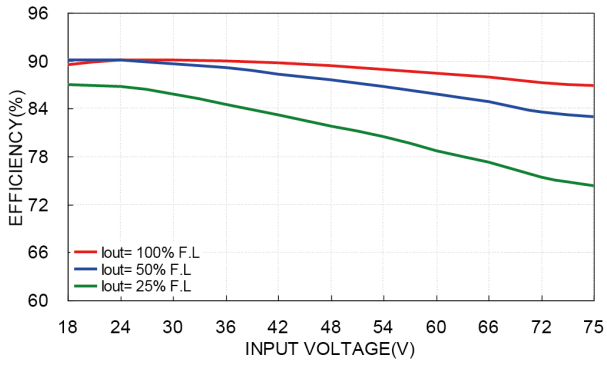
Efficiency versus Output Load



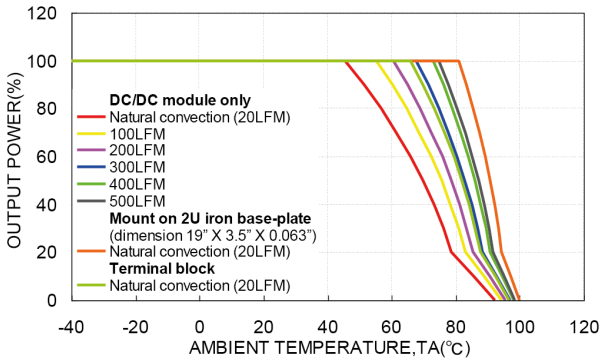
Power Dissipation versus Output Load



Efficiency versus Input Voltage

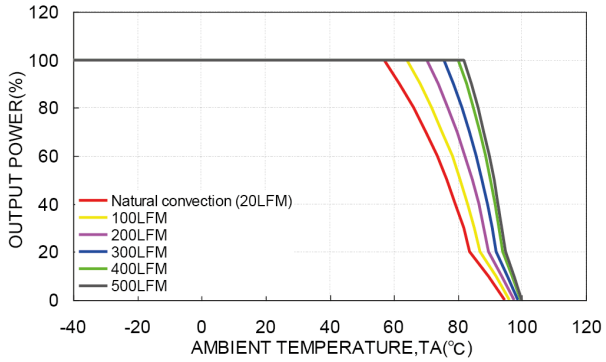


Derating Output Load versus Ambient Temperature



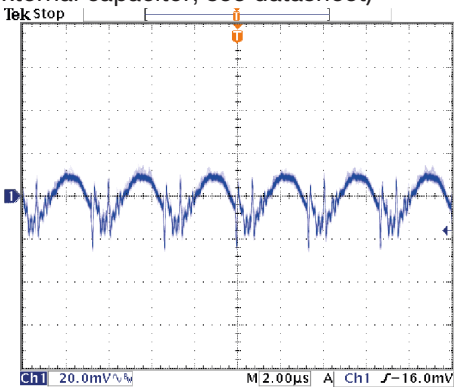
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

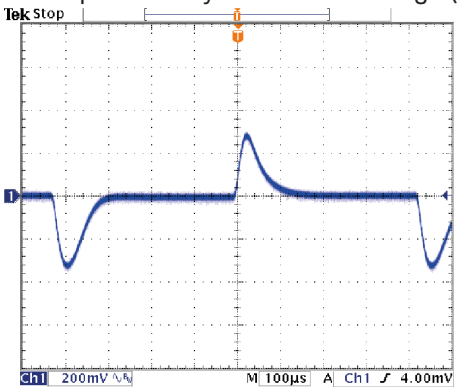


TEP 75-4813WI
TEP 75-4813WI-CM
TEP 75-4813WI-CMF

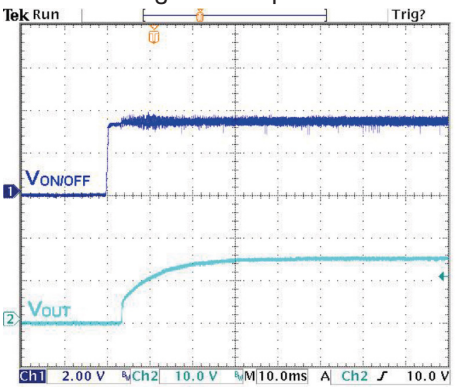
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



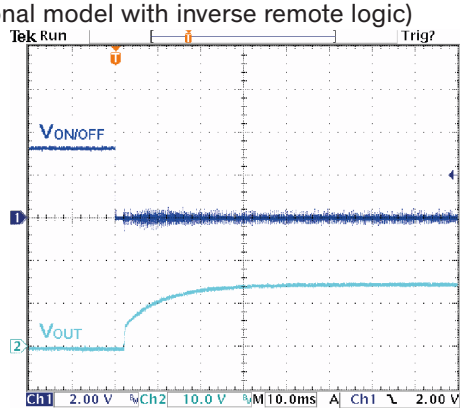
Transient Response to Dynamic Load Change (25%)



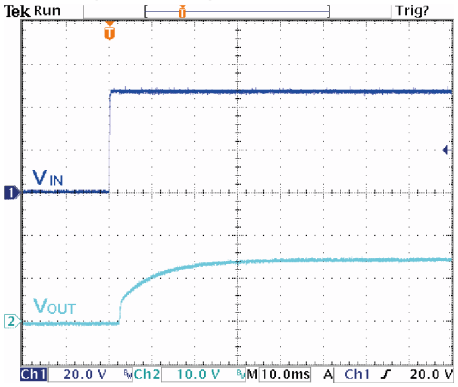
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

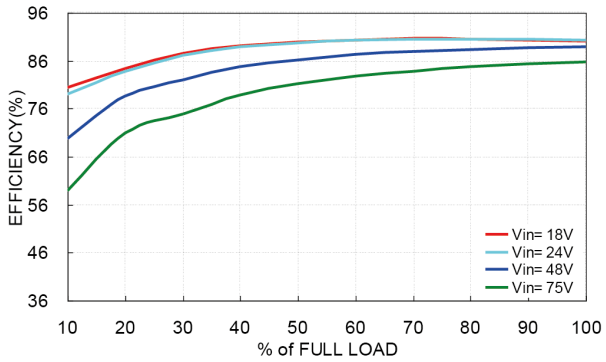


Typical Start-Up and Output Rise Characteristic

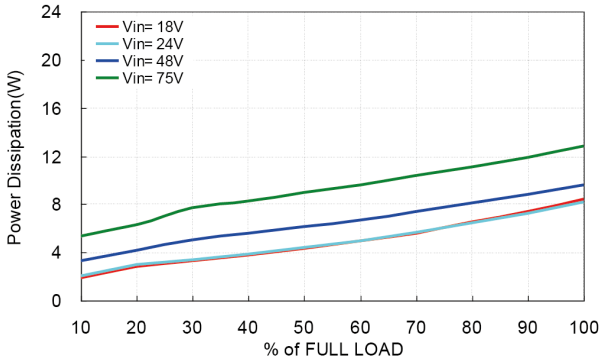


TEP 75-4815WI
TEP 75-4815WI-CM
TEP 75-4815WI-CMF

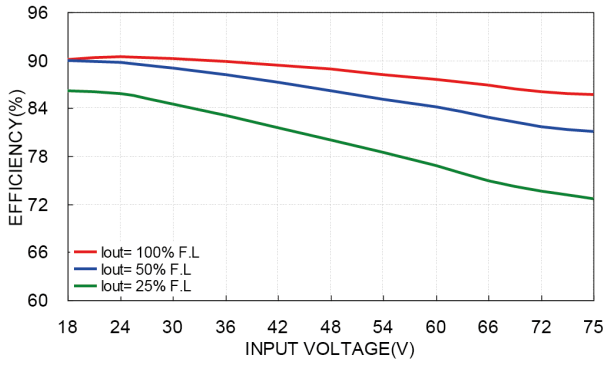
Efficiency versus Output Load



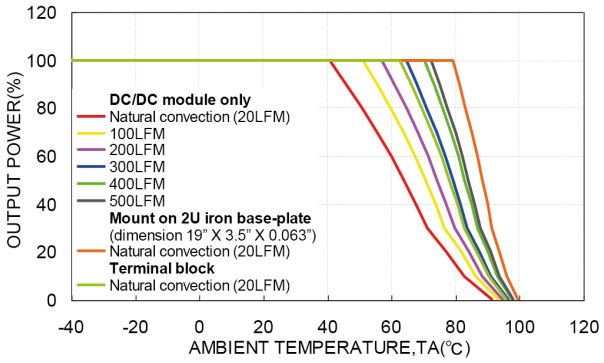
Power Dissipation versus Output Load



Efficiency versus Input Voltage

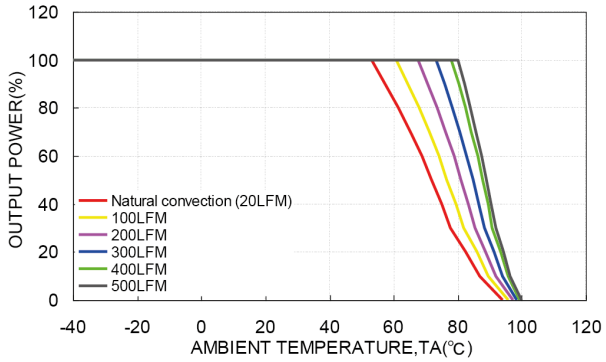


Derating Output Load versus Ambient Temperature



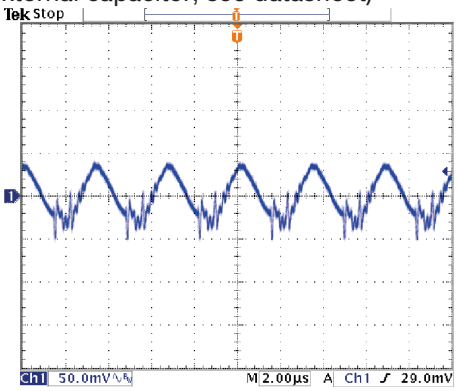
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

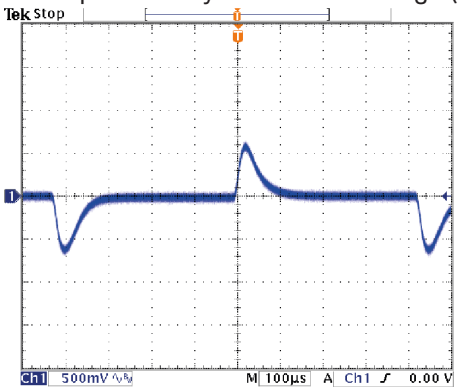


TEP 75-4815WI
TEP 75-4815WI-CM
TEP 75-4815WI-CMF

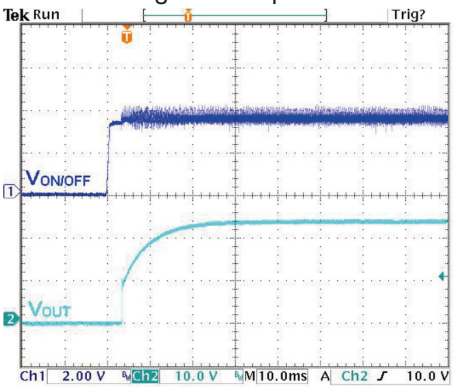
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



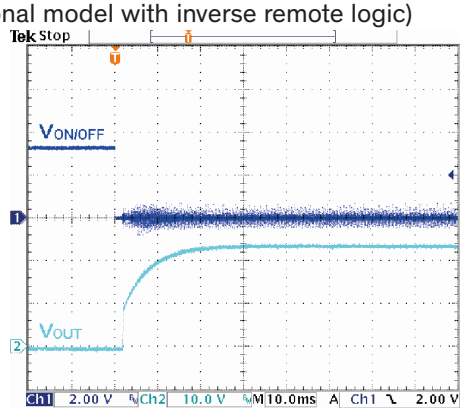
Transient Response to Dynamic Load Change (25%)



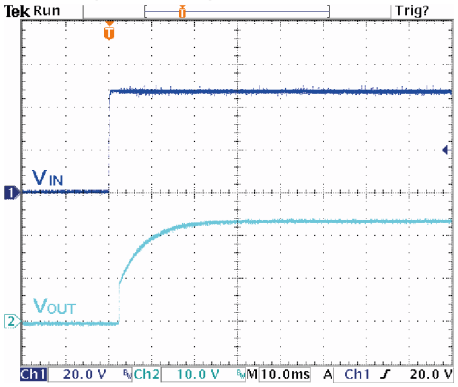
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

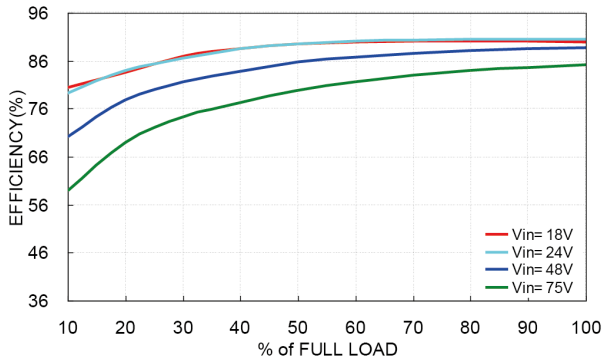


Typical Start-Up and Output Rise Characteristic

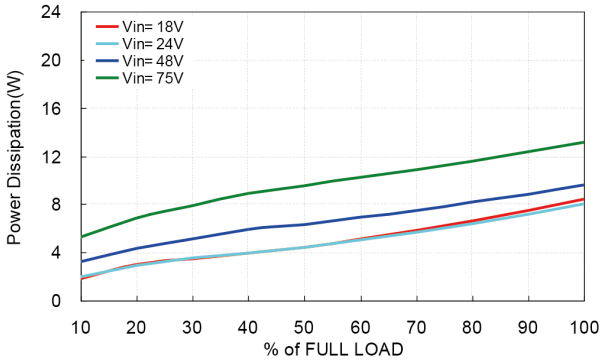


TEP 75-4816WI
TEP 75-4816WI-CM
TEP 75-4816WI-CMF

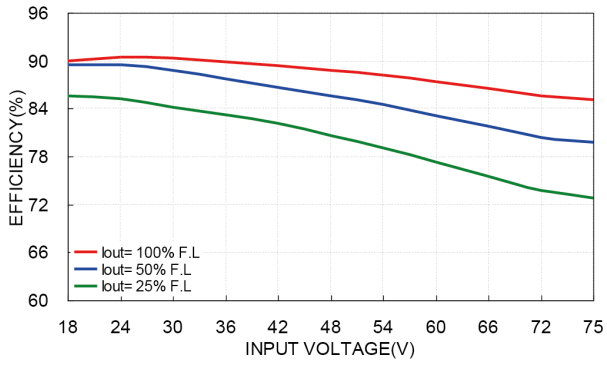
Efficiency versus Output Load



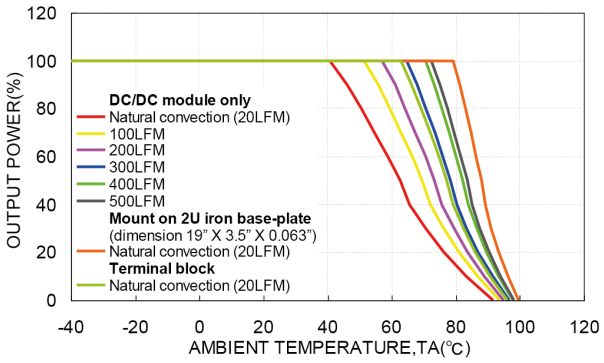
Power Dissipation versus Output Load



Efficiency versus Input Voltage

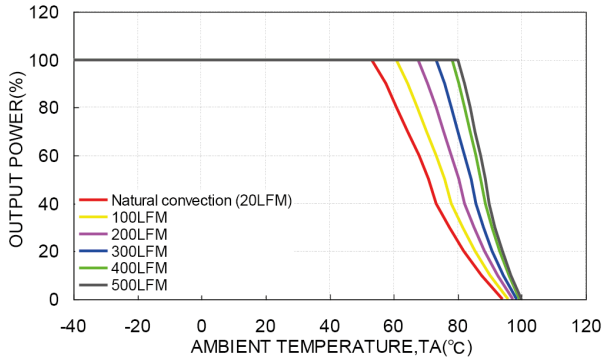


Derating Output Load versus Ambient Temperature



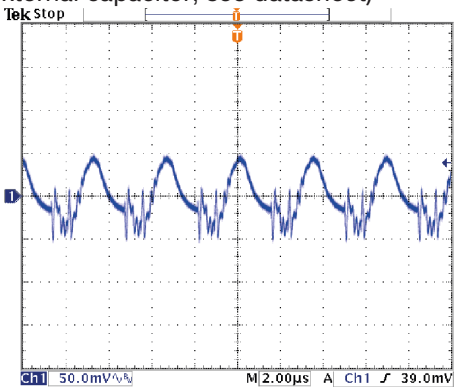
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

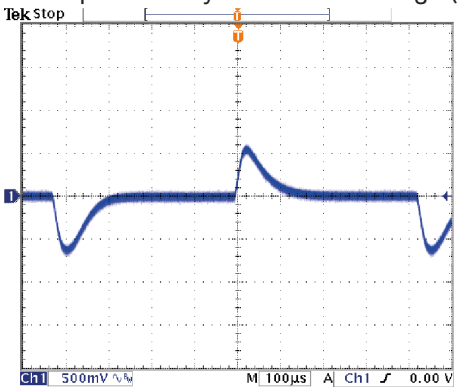


TEP 75-4816WI
TEP 75-4816WI-CM
TEP 75-4816WI-CMF

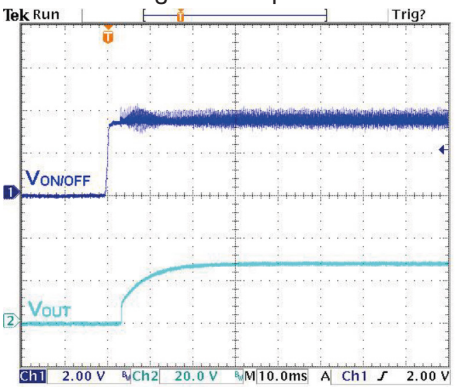
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



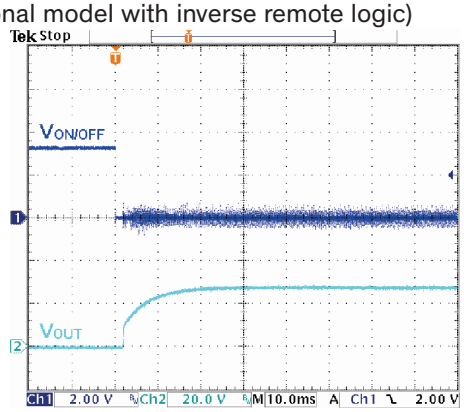
Transient Response to Dynamic Load Change (25%)



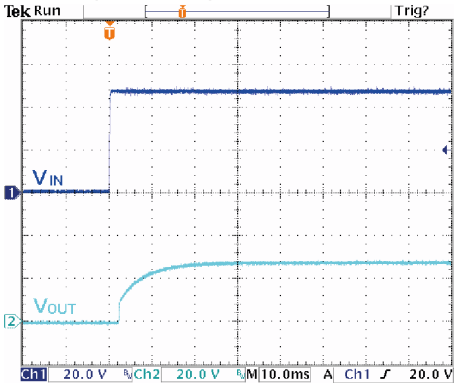
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

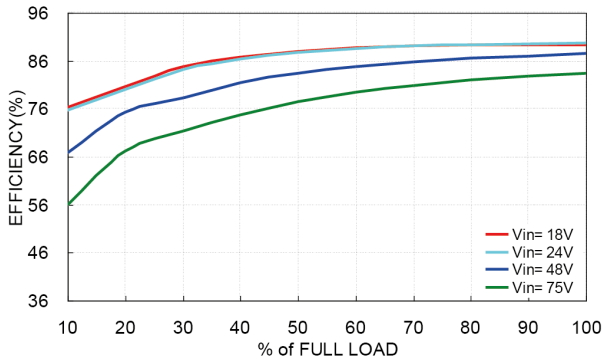


Typical Start-Up and Output Rise Characteristic

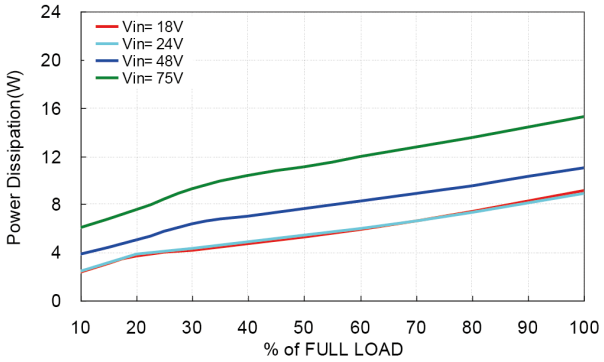


TEP 75-4818WI
TEP 75-4818WI-CM
TEP 75-4818WI-CMF

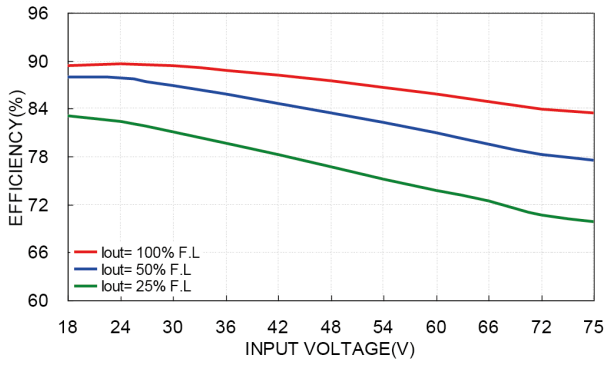
Efficiency versus Output Load



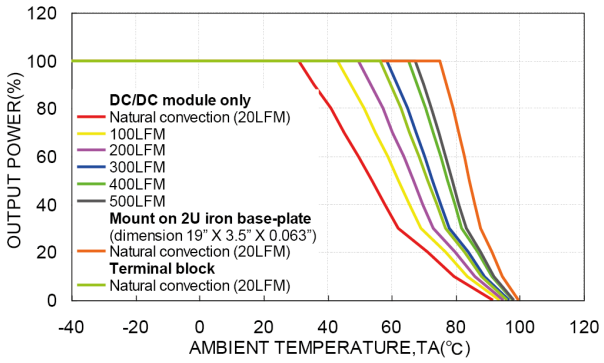
Power Dissipation versus Output Load



Efficiency versus Input Voltage

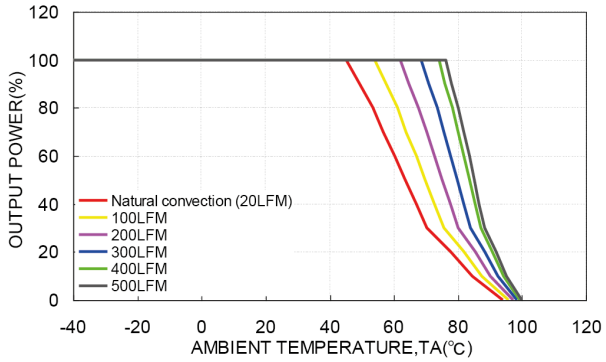


Derating Output Load versus Ambient Temperature



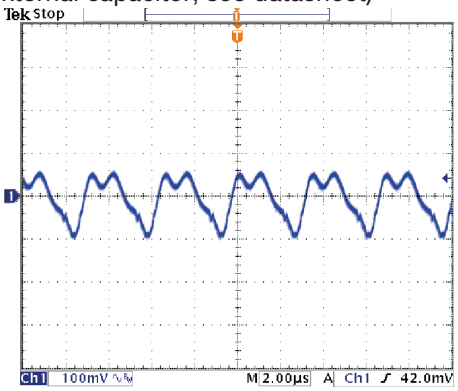
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

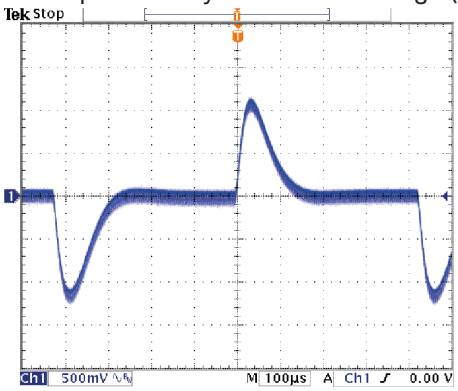


TEP 75-4818WI
TEP 75-4818WI-CM
TEP 75-4818WI-CMF

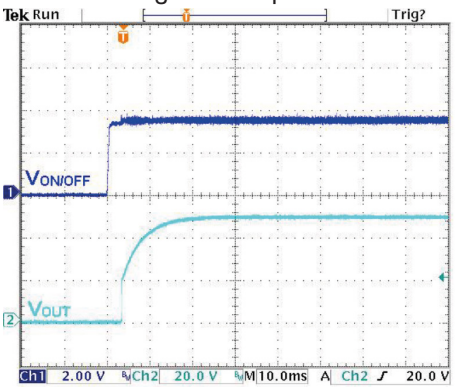
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



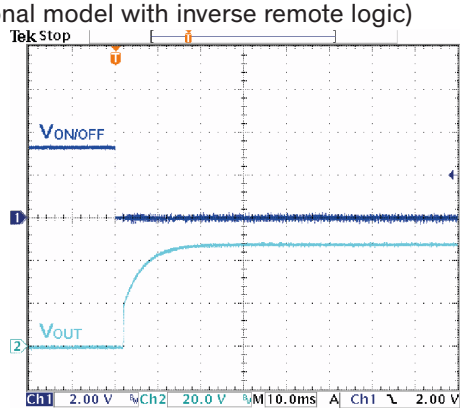
Transient Response to Dynamic Load Change (25%)



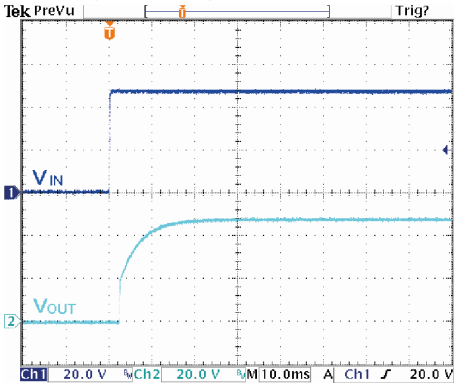
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

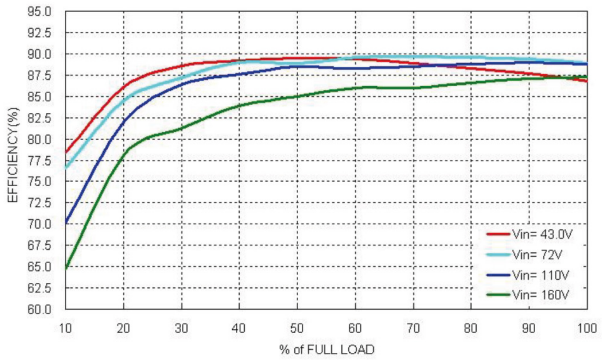


Typical Start-Up and Output Rise Characteristic

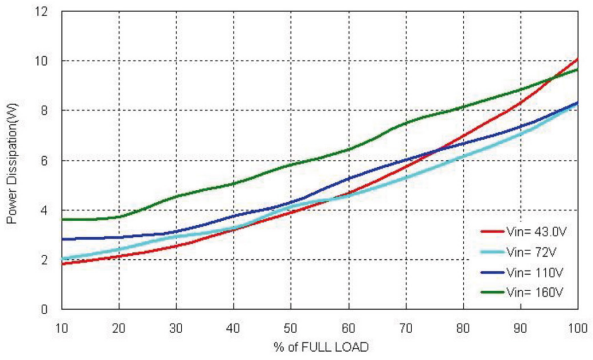


On demand model with 110 Vin and 3.3 Vout
On demand model with 110 Vin and 3.3 Vout for chassis mount
On demand model with 110 Vin and 3.3 Vout for chassis mount and with input filter

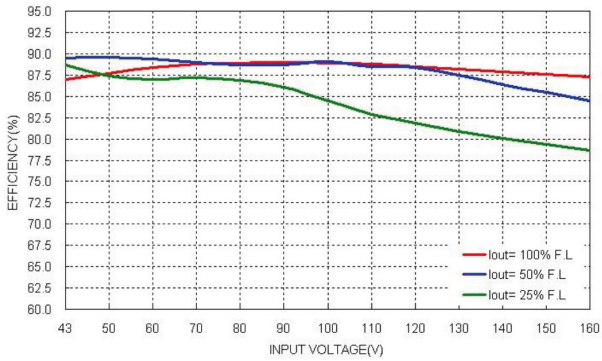
Efficiency versus Output Load



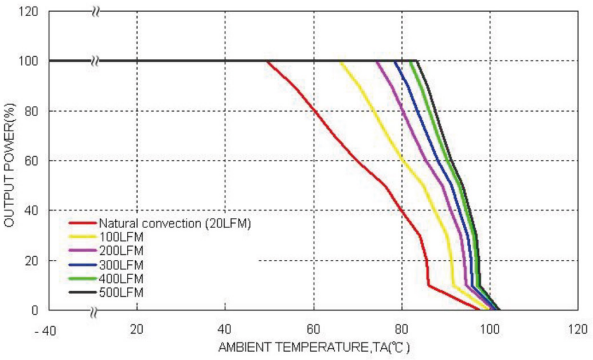
Power Dissipation versus Output Load



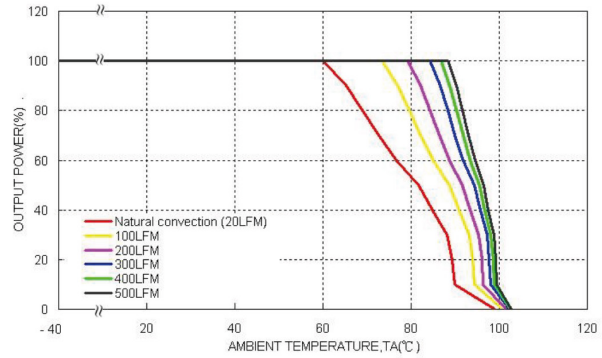
Efficiency versus Input Voltage



Derating Output Load versus Ambient Temperature

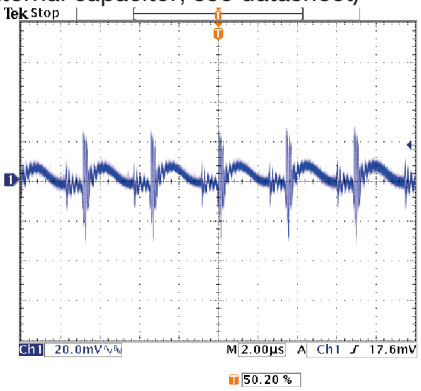


Derating Output Load versus Ambient Temperature
with optional Heatsink TEP-HS1
(PCB mount model only)

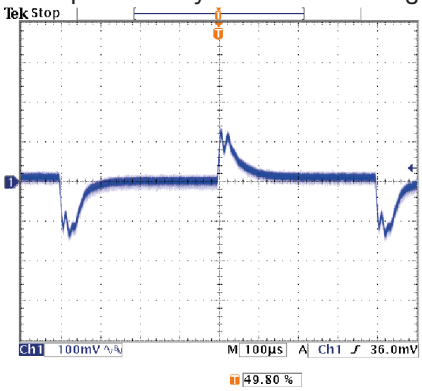


On demand model with 110 Vin and 3.3 Vout
On demand model with 110 Vin and 3.3 Vout for chassis mount
On demand model with 110 Vin and 3.3 Vout for chassis mount and with input filter

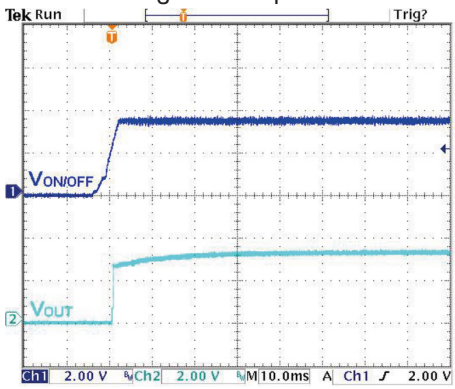
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



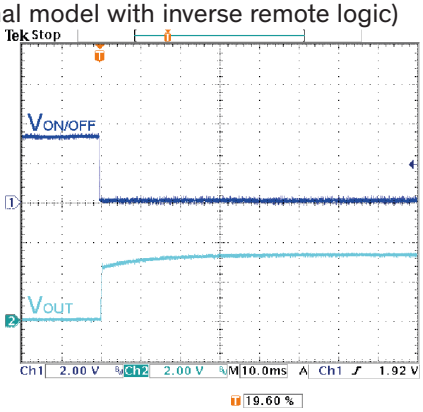
Transient Response to Dynamic Load Change (25%)



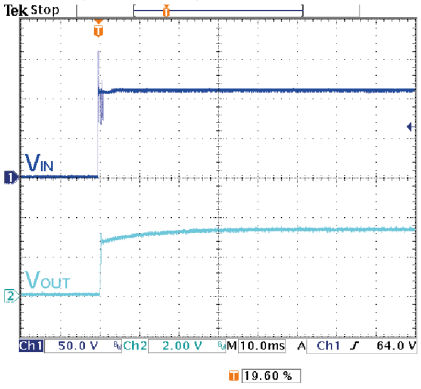
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

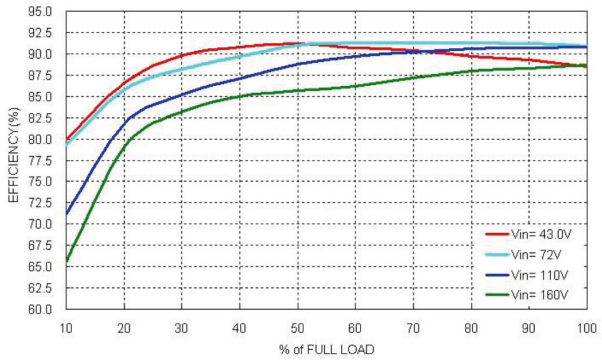


Typical Start-Up and Output Rise Characteristic

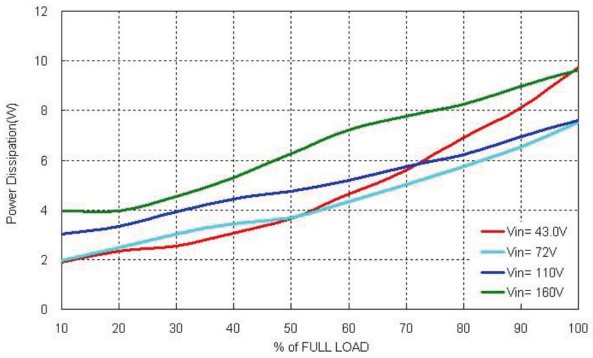


TEP 75-7211WI
TEP 75-7211WI-CM
TEP 75-7211WI-CMF

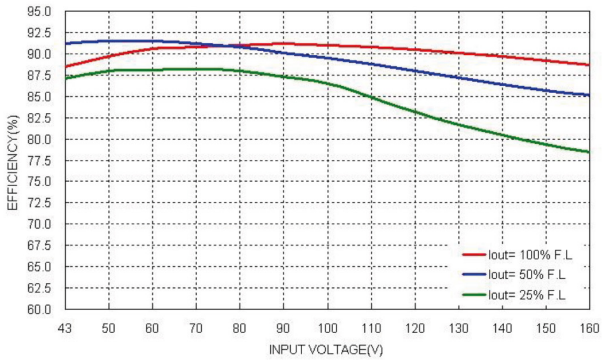
Efficiency versus Output Load



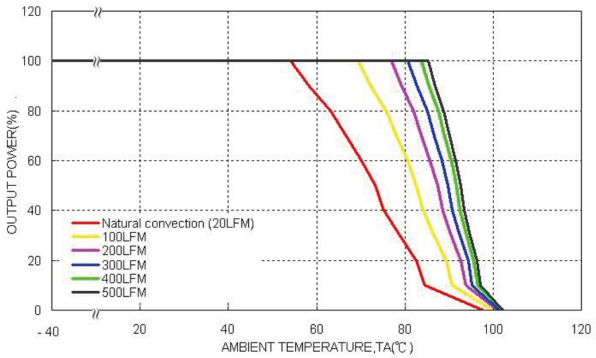
Power Dissipation versus Output Load



Efficiency versus Input Voltage

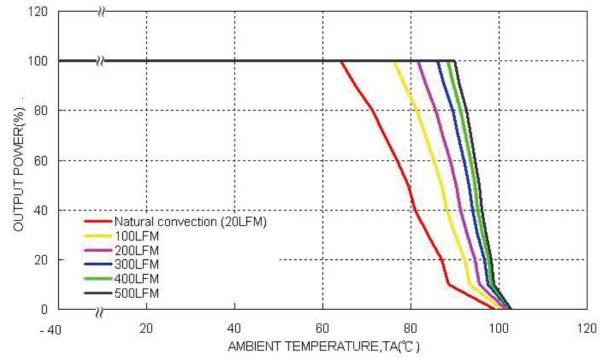


Derating Output Load versus Ambient Temperature



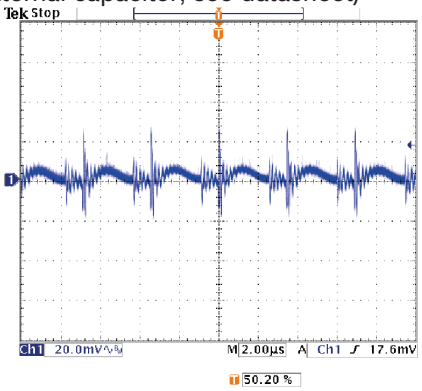
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

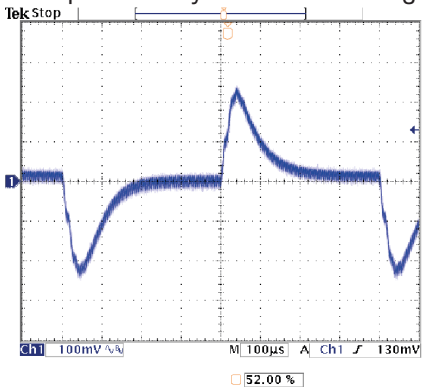


TEP 75-7211WI
TEP 75-7211WI-CM
TEP 75-7211WI-CMF

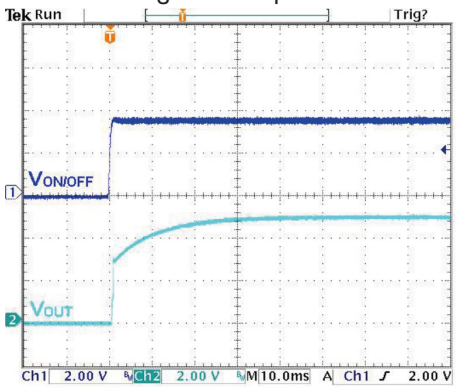
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



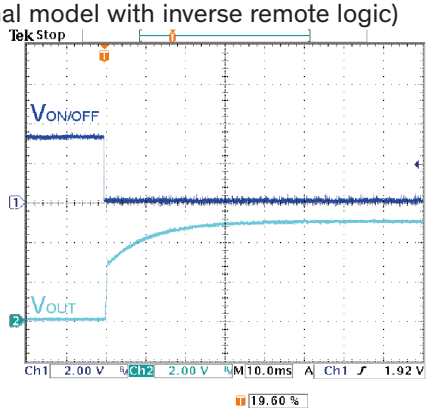
Transient Response to Dynamic Load Change (25%)



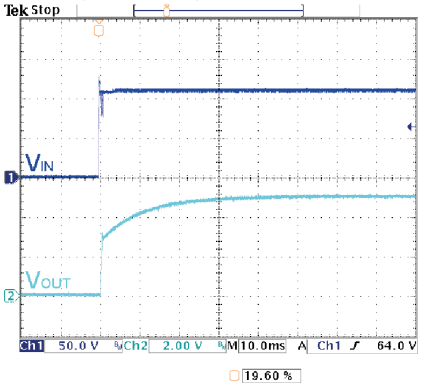
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

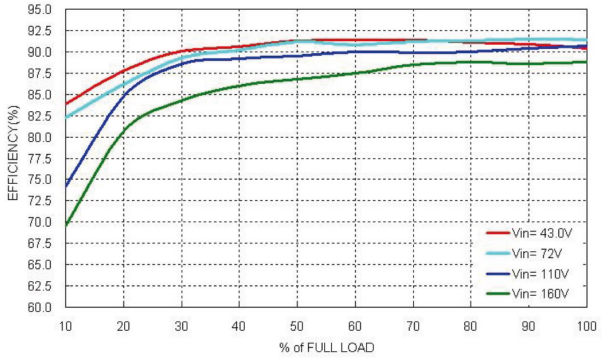


Typical Start-Up and Output Rise Characteristic

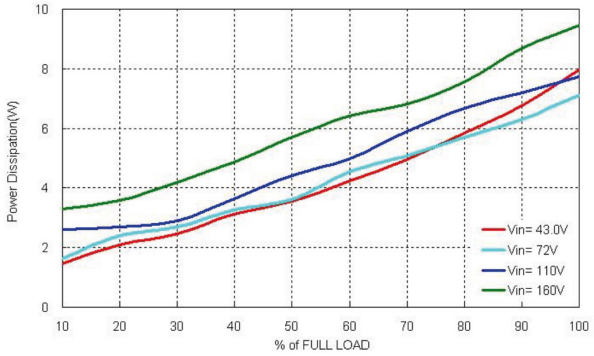


TEP 75-7212WI
TEP 75-7212WI-CM
TEP 75-7212WI-CMF

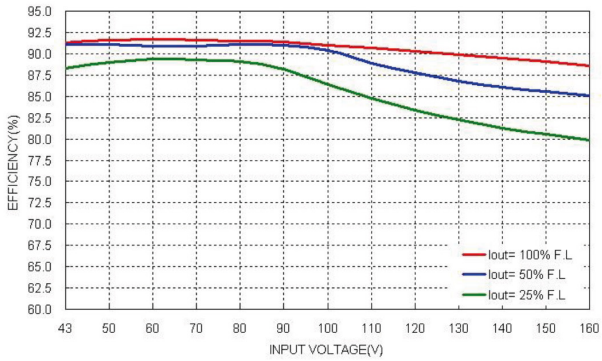
Efficiency versus Output Load



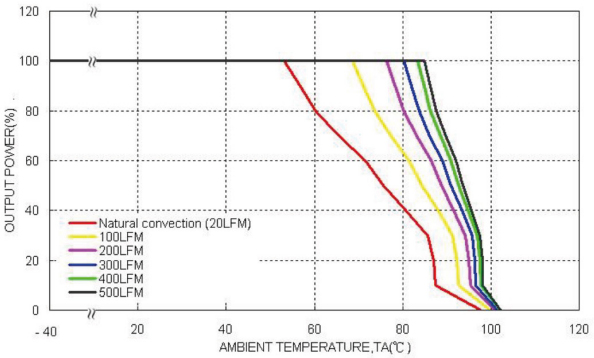
Power Dissipation versus Output Load



Efficiency versus Input Voltage

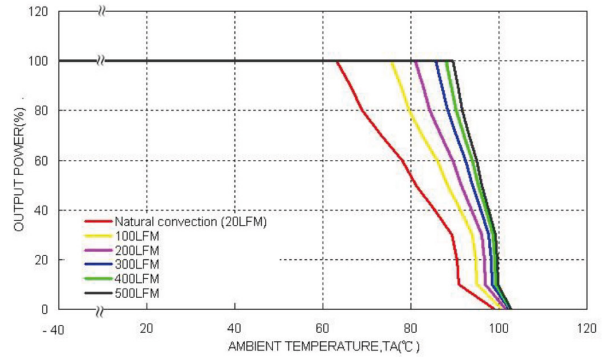


Derating Output Load versus Ambient Temperature



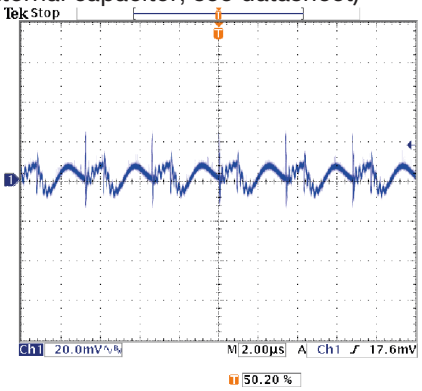
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

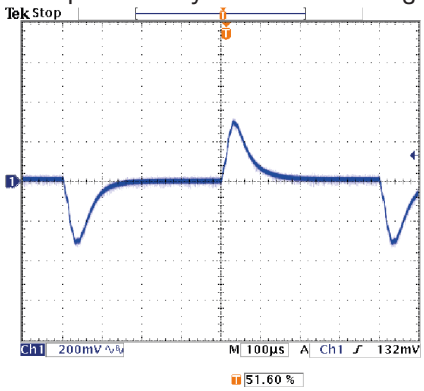


TEP 75-7212WI
TEP 75-7212WI-CM
TEP 75-7212WI-CMF

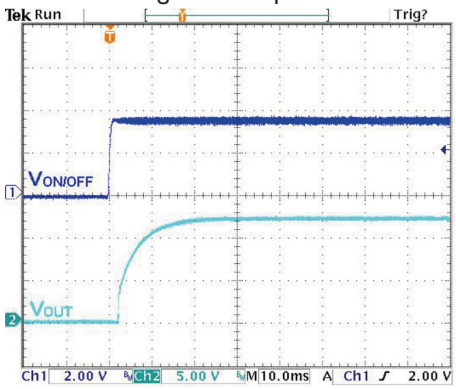
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



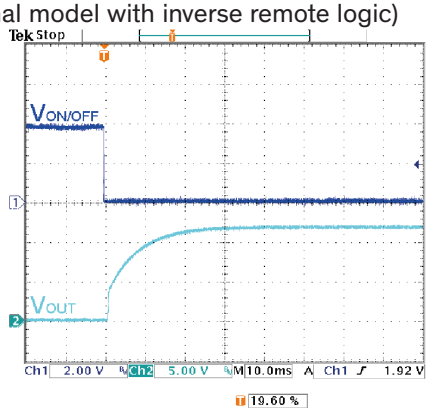
Transient Response to Dynamic Load Change (25%)



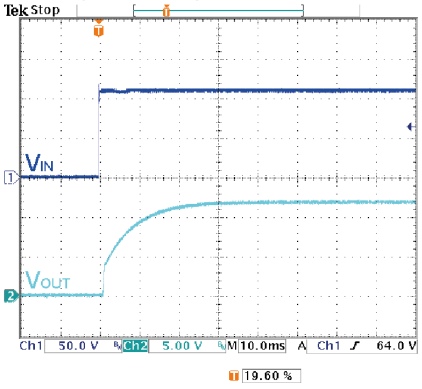
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

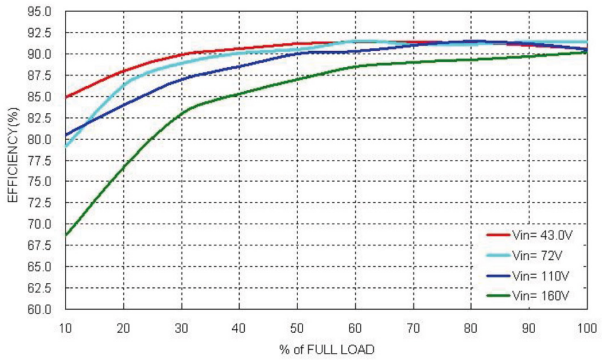


Typical Start-Up and Output Rise Characteristic

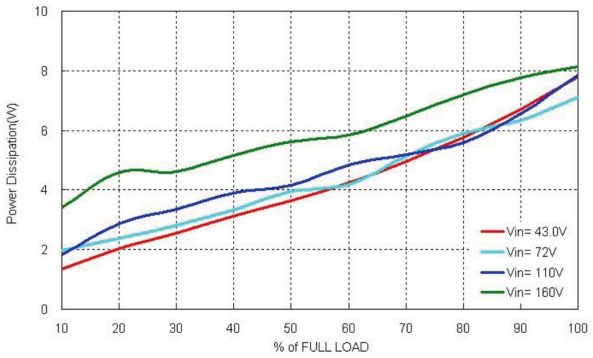


TEP 75-7213WI
TEP 75-7213WI-CM
TEP 75-7213WI-CMF

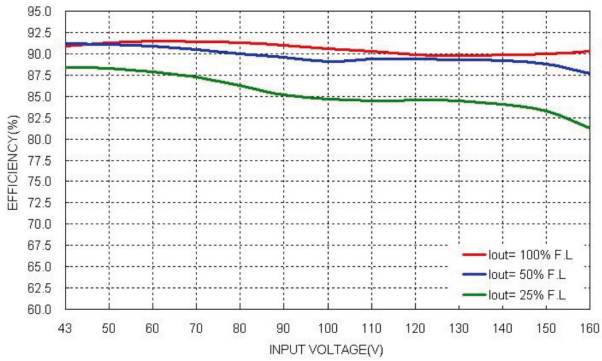
Efficiency versus Output Load



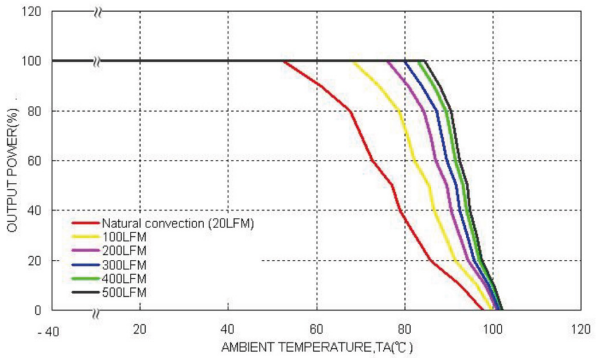
Power Dissipation versus Output Load



Efficiency versus Input Voltage

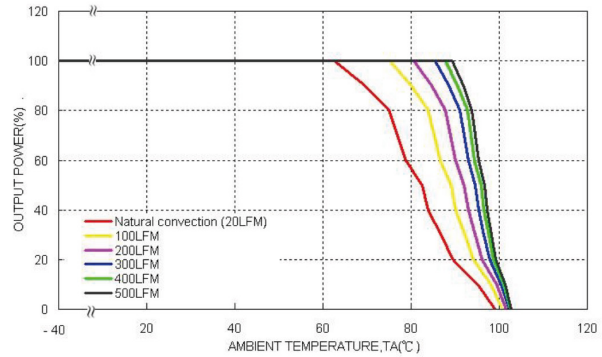


Derating Output Load versus Ambient Temperature



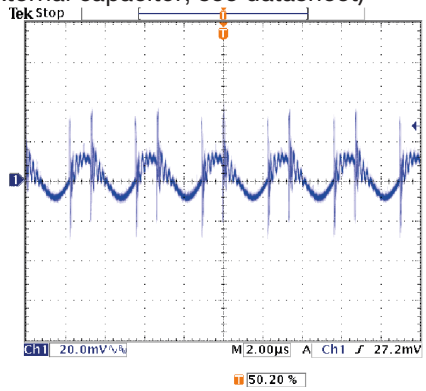
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

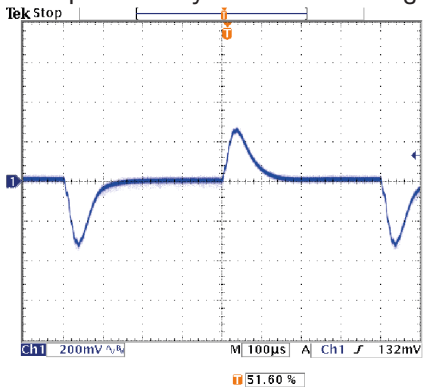


TEP 75-7213WI
TEP 75-7213WI-CM
TEP 75-7213WI-CMF

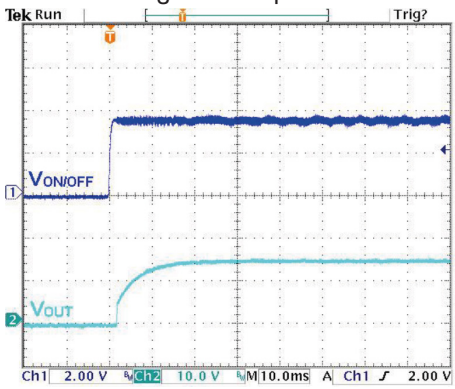
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



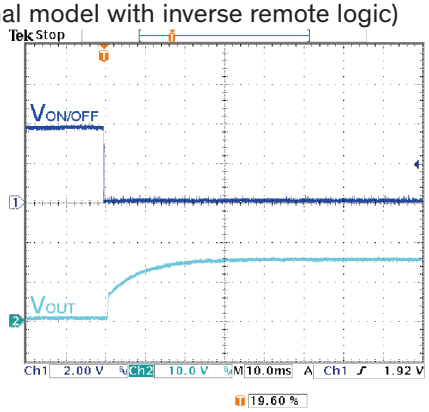
Transient Response to Dynamic Load Change (25%)



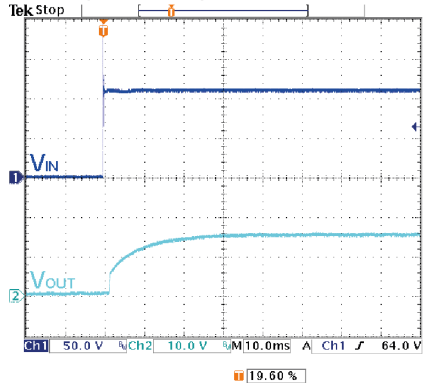
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

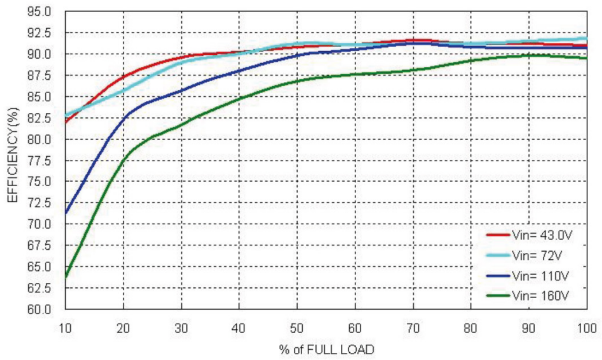


Typical Start-Up and Output Rise Characteristic

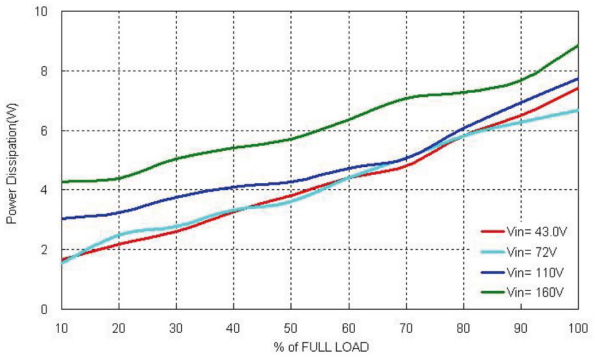


TEP 75-7215WI
TEP 75-7215WI-CM
TEP 75-7515WI-CMF

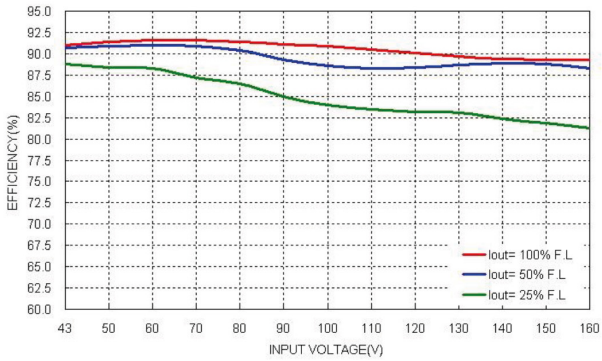
Efficiency versus Output Load



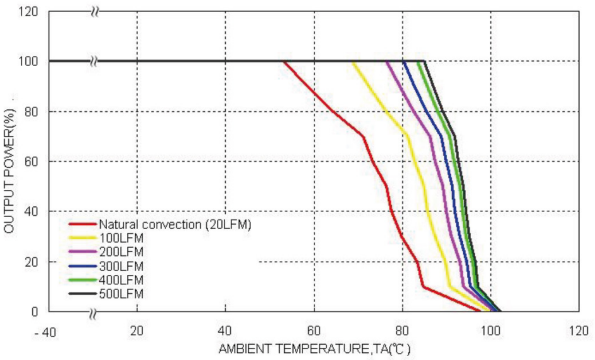
Power Dissipation versus Output Load



Efficiency versus Input Voltage

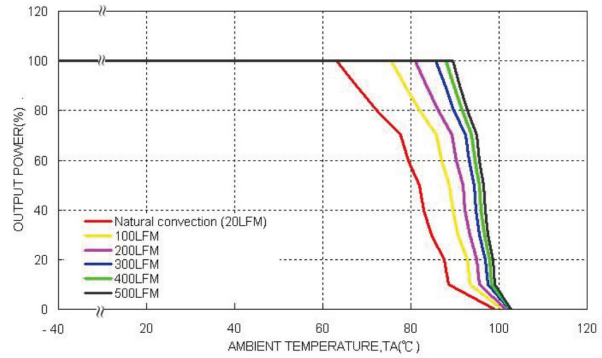


Derating Output Load versus Ambient Temperature



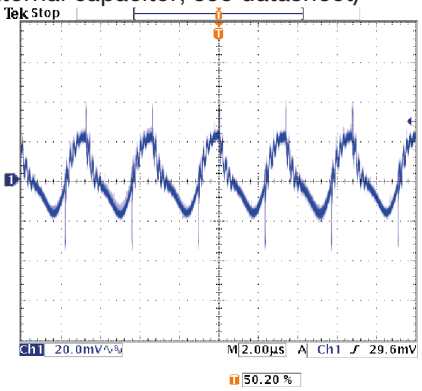
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

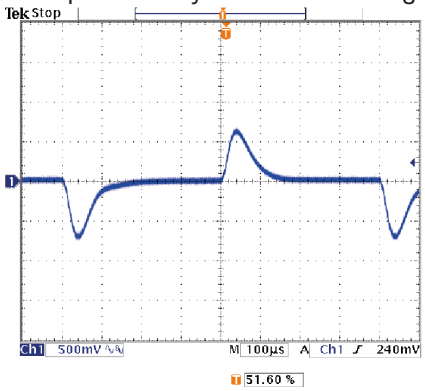


TEP 75-7215WI
TEP 75-7215WI-CM
TEP 75-7515WI-CMF

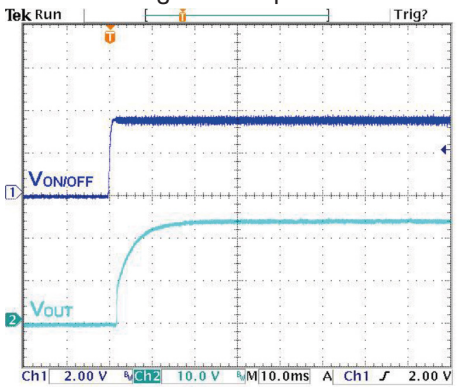
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



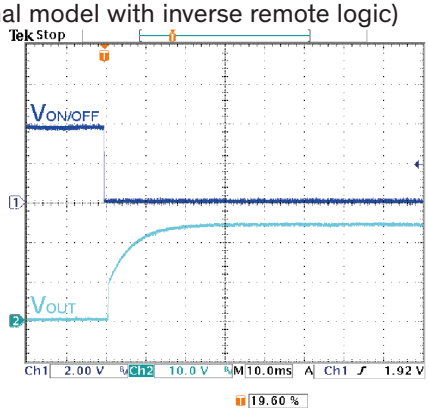
Transient Response to Dynamic Load Change (25%)



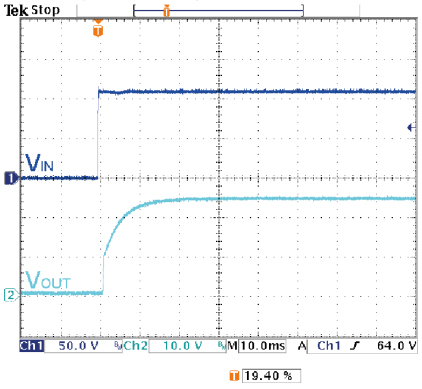
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

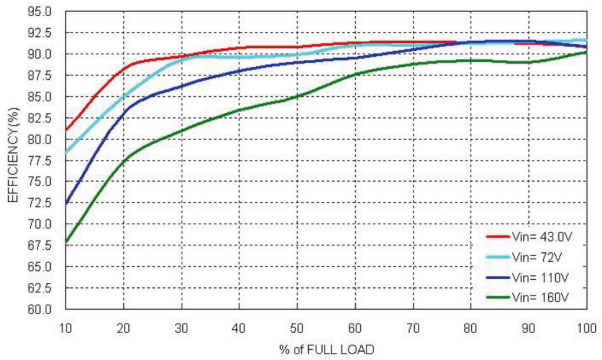


Typical Start-Up and Output Rise Characteristic

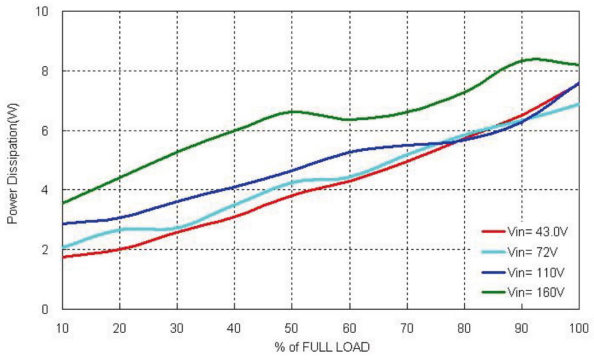


TEP 75-7216WI
TEP 75-7216WI-CM
TEP 75-7216WI-CMF

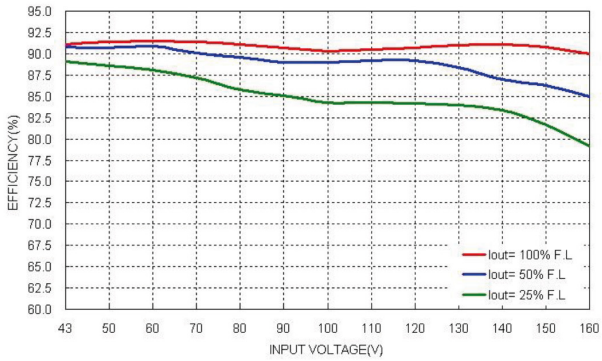
Efficiency versus Output Load



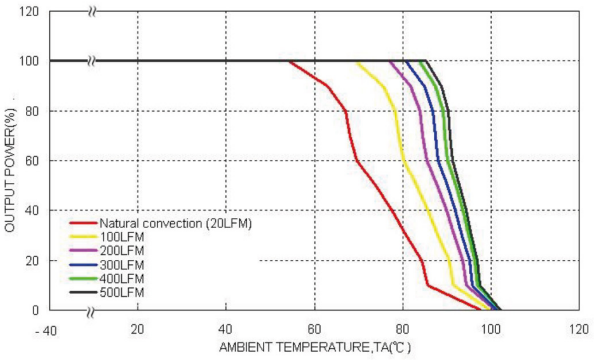
Power Dissipation versus Output Load



Efficiency versus Input Voltage

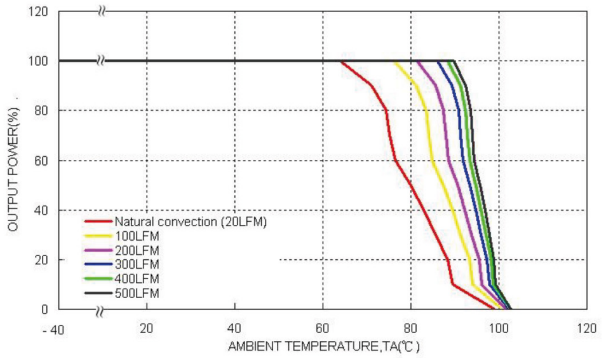


Derating Output Load versus Ambient Temperature



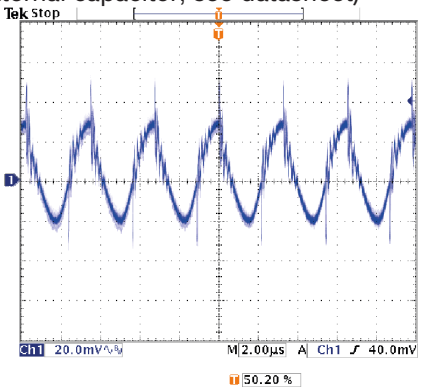
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

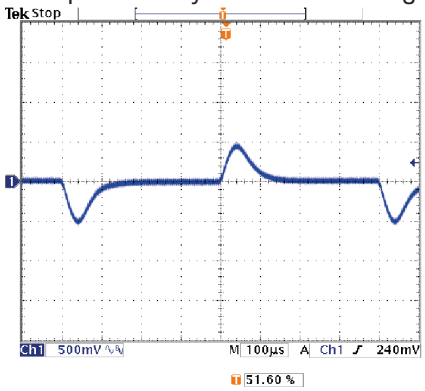


TEP 75-7216WI
TEP 75-7216WI-CM
TEP 75-7216WI-CMF

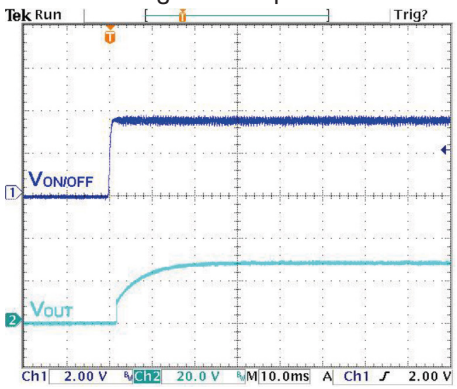
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



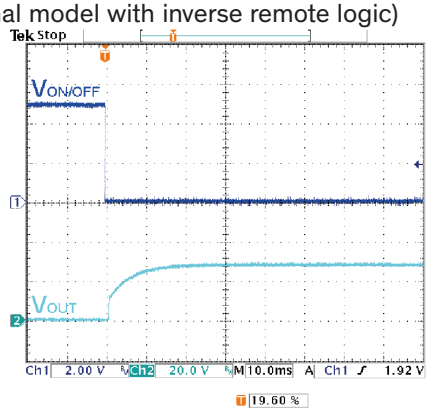
Transient Response to Dynamic Load Change (25%)



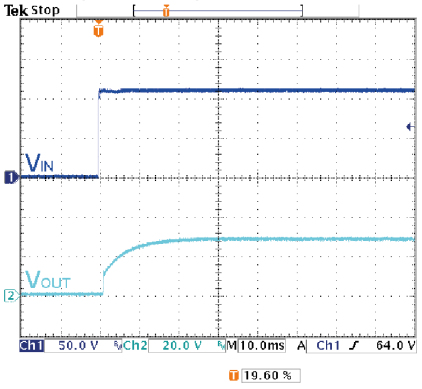
Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)

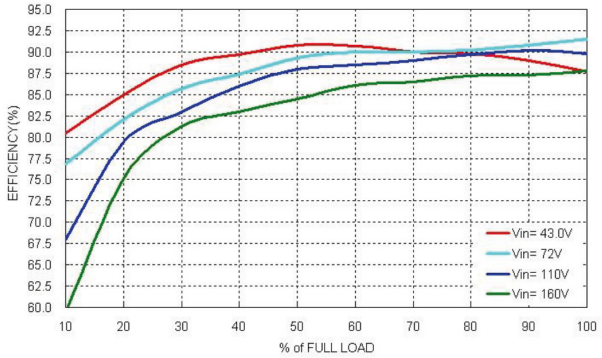


Typical Start-Up and Output Rise Characteristic

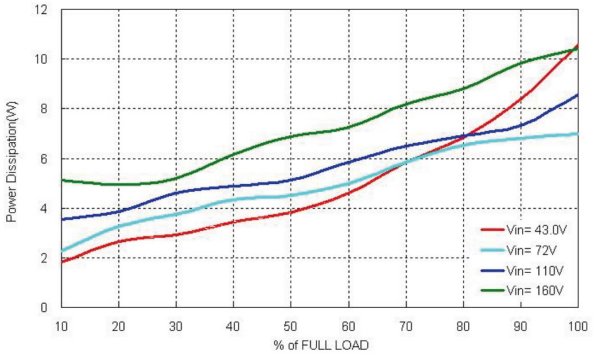


TEP 75-7218WI
TEP 75-7218WI-CM
TEP 75-7218WI-CMF

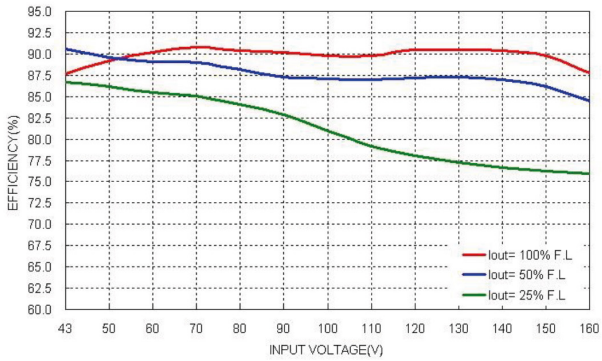
Efficiency versus Output Load



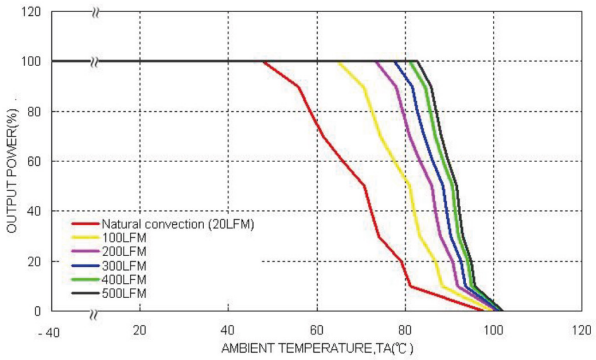
Power Dissipation versus Output Load



Efficiency versus Input Voltage

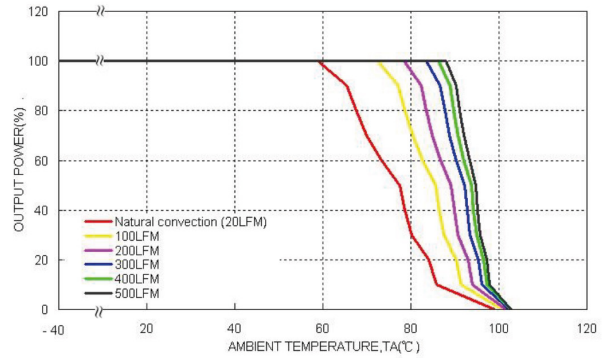


Derating Output Load versus Ambient Temperature



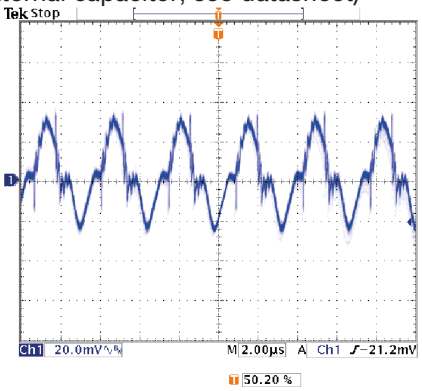
Derating Output Load versus Ambient Temperature with optional Heatsink TEP-HS1

(PCB mount model only)

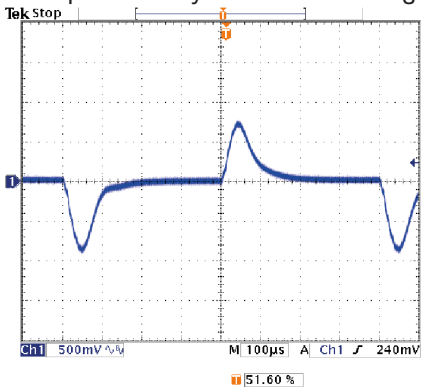


TEP 75-7218WI
TEP 75-7218WI-CM
TEP 75-7218WI-CMF

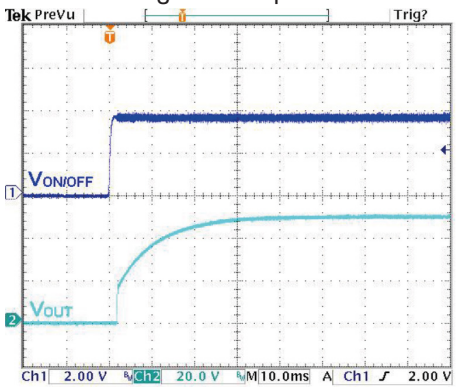
Typical Output Ripple and Noise
(with external capacitor; see datasheet)



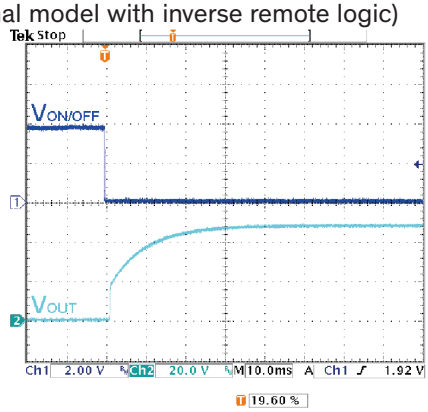
Transient Response to Dynamic Load Change (25%)



Remote on/off Voltage Start-Up Characteristic



Remote on/off Voltage Start-Up Characteristic
(Optional model with inverse remote logic)



Typical Start-Up and Output Rise Characteristic